AirPrime EM7565

Product Technical Specification

SIERRA WIRELESS®

Important Notice

Due to the nature of wireless communications, transmission and reception of data can never be guaranteed. Data may be delayed, corrupted (i.e., have errors) or be totally lost. Although significant delays or losses of data are rare when wireless devices such as the Sierra Wireless modem are used in a normal manner with a well-constructed network, the Sierra Wireless modem should not be used in situations where failure to transmit or receive data could result in damage of any kind to the user or any other party, including but not limited to personal injury, death, or loss of property. Sierra Wireless accepts no responsibility for damages of any kind resulting from delays or errors in data transmitted or received using the Sierra Wireless modem, or for failure of the Sierra Wireless modem to transmit or receive such data.

Safety and Hazards

Do not operate the Sierra Wireless modem in areas where blasting is in progress, where explosive atmospheres may be present, near medical equipment, near life support equipment, or any equipment which may be susceptible to any form of radio interference. In such areas, the Sierra Wireless modem **MUST BE POWERED OFF**. The Sierra Wireless modem can transmit signals that could interfere with this equipment.

Do not operate the Sierra Wireless modem in any aircraft, whether the aircraft is on the ground or in flight. In aircraft, the Sierra Wireless modem **MUST BE POWERED OFF**. When operating, the Sierra Wireless modem can transmit signals that could interfere with various onboard systems.

Note: Some airlines may permit the use of cellular phones while the aircraft is on the ground and the door is open. Sierra Wireless modems may be used at this time.

The driver or operator of any vehicle should not operate the Sierra Wireless modem while in control of a vehicle. Doing so will detract from the driver or operator's control and operation of that vehicle. In some states and provinces, operating such communications devices while in control of a vehicle is an offence.

Limitation of Liability

The information in this manual is subject to change without notice and does not represent a commitment on the part of Sierra Wireless. SIERRA WIRELESS AND ITS AFFILIATES SPECIFICALLY DISCLAIM LIABILITY FOR ANY AND ALL DIRECT, INDIRECT, SPECIAL, GENERAL, INCIDENTAL, CONSEQUENTIAL, PUNITIVE OR EXEMPLARY DAMAGES INCLUDING, BUT NOT LIMITED TO, LOSS OF PROFITS OR REVENUE OR ANTICIPATED PROFITS OR REVENUE ARISING OUT OF THE USE OR INABILITY TO USE ANY SIERRA WIRELESS PRODUCT, EVEN IF SIERRA WIRELESS AND/OR ITS AFFILIATES HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES OR THEY ARE FORESEEABLE OR FOR CLAIMS BY ANY THIRD PARTY.

Notwithstanding the foregoing, in no event shall Sierra Wireless and/or its affiliates aggregate liability arising under or in connection with the Sierra Wireless product, regardless of the number of events, occurrences, or claims giving rise to liability, be in excess of the price paid by the purchaser for the Sierra Wireless product.

Patents

This product may contain technology developed by or for Sierra Wireless Inc. This product includes technology licensed from QUALCOMM®. This product is manufactured or sold by Sierra Wireless Inc. or its affiliates under one or more patents licensed from InterDigital Group and MMP Portfolio Licensing.

Copyright

©2018 Sierra Wireless. All rights reserved.

Trademarks

Sierra Wireless®, AirPrime®, AirLink®, AirVantage® and the Sierra Wireless logo are registered trademarks of Sierra Wireless, Inc.

Windows® and Windows Vista® are registered trademarks of Microsoft Corporation.

QUALCOMM® is a registered trademark of QUALCOMM Incorporated. Used under license.

Other trademarks are the property of their respective owners.

Contact Information

Sales information and technical support, including warranty and returns	Web: sierrawireless.com/company/contact-us/ Global toll-free number: 1-877-687-7795 6:00 am to 6:00 pm PST
Corporate and product information	Web: sierrawireless.com

Revision History

Revision number	Release date	Changes
1	April 2017	Initial release
2	June 2017	Added Power On/Off Timing for the USB section
3	June 2017	Updated notes indicating how long host must wait to drive signals at power-on (in Host Interface Pin Assignments, Power On/Off Timing for the USB, and Power On Timing for PCIe Port)
4	June 2017	Corrected appendix table/figure numbering and TOC formatting
5	July 2017	Added uplink carrier aggregation combinations Removed Bands 252/255

Revision number	Release date	Changes
6	February 2018	Added Carrier Aggregation tables
		Added max values for ClassA / ClassB operating temperatures
		Updated 3GPP LTE Release #
		Updated Table 3-1—VCC typical value, pin 8 voltages, PCIE pin voltages
		Removed PCIe Interface section and Power-on Timing for PCIe
		Added Recommended Capacitor Placement details for USB3.0
		Updated USB Throughput Performance details
		Updated LTE Conducted Rx Sensitivity table
		Updated Conducted Tx Power Tolerances table—LTE B30
		Updated Averaged Standby DC Power Consumption table
		Updated Averaged Call Mode DC Power Consumption table
		Updated Miscellaneous DC Power Consumption table
		Updated Power State Transition Trigger Levels (Temperature values)
		Updated USB timing parameters
		Updated USB Enumeration description
		Updated Product Marking (Labeling) example
		Updated Regulatory Compliance chapter—Antenna gain table, FCC/IC IDs
		Updated Test Settings for UMTS and LTE Rx and Tx
7	April 2018	Added Required Shutdown Sequence on page 54
		Updated Electrical Specifications WAN_LED_N description to not include GNSS
		Added GPS_DISABLE# Input high voltage detail
		Marked LTE B42/B43/B48 as disabled
		Removed B42C from UL CA list
		Removed WCDMA Band 3
		Updated RESET# usage in Table 3-7, Full_Card_Power_Off# and RESET# Usage, on page 35
8	October 2018	Updated PTCRB Carrier Aggregation Download Combinations
		Updated Power-on signal timing graphic and host signals note
		Updated PCI_PERST_N voltage levels
		LTE B30 noted as downlink only
		Replaced references to !RXDEN with !LTERXCONTROL
		Updated envelope correlation coefficient values
		Updated topic Disabling the Diversity Antenna
		Updated TEMP_HI_CRIT value

⟩⟩| Contents

List of Tables

List of Figures

1: Introduction

The Sierra Wireless EM7565 Embedded Module is an M.2 module that provides LTE, UMTS, and GNSS connectivity for notebook, ultrabook, tablet computers, and M2M applications over several radio frequency bands.

Supported RF bands

The modem, based on Qualcomm's MDM9250 baseband processor, supports data operation on LTE and UMTS networks over the bands described in Table 1-1, with LTE carrier aggregation (CA) as described in Table 1-2 and Table 1-3.

Table 1-1: Supported RF Bands

RAT	Bands																								
	1	2	3	4	5	6	7	8	9	12	13	18	19	20	26	28	29	30	32	41	42	43	46	48	66
LTE[a]	F	F	F	F	F		F	F	F	F	F	F	F	F	F	F	F[b]	F[b]	F[b]	T	T[c]	T[c]	T[b]	T[c]	F
UMTS[d]	Y	Y		Y	Y	Y		Y	Y				Y		N/A					N/A					
GNSS	• GPS: 1575.42 MHz • GLONASS: 1602 MHz • BeiDou: 1561.098 MHz • Galileo: 1575.42 MHz • QZSS: 1575.42 MHz																								

a. (LTE) Downlink MIMO support (2x2; 4x2)
   F=FDD; T=TDD
   Data rates: Downlink (Cat 12 with 3CA, 256QAM=600 Mbps; Cat 9 with 3CA, 64QAM=450 Mbps), Uplink (Cat 13 with 2CA contiguous, 64QAM=150 Mbps)
b. Downlink only
c. B42/B43/B48 disabled as of publication date, support pending regulatory approval
d. UMTS (DC-HSPA+, HSPA+, HSPA, UMTS)
   Diversity support
   Data rates: Downlink (Cat 24, up to 42 Mbps), Uplink (Cat 6, up to 11 Mbps)

Table 1-2: PTCRB Carrier Aggregation Downlink Combinations[a]

1 Band/2CC	1 Band/3CC	2 Bands/2CC	2 Bands/3CC	3 Bands/3CC
		CA_1A-3A	CA_1A-7A-7A	CA_1A-3A-5A
		CA_1A-5A		CA_1A-3A-7A
		CA_1A-7A		CA_1A-3A-8A
		CA_1A-18A		CA_1A-3A-19A
		CA_1A-19A		CA_1A-3A-20A
		CA_1A-20A		CA_1A-5A-7A
		CA_1A-26A		CA_1A-7A-20A
		CA_1A-41A		
CA_2A-2A		CA_2A-4A	CA_2A-2A-5A	CA_2A-4A-5A
CA_2C		CA_2A-7A	CA_2A-2A-12A	CA_2A-4A-7A
		CA_2A-12A	CA_2A-2A-13A	CA_2A-4A-12A
		CA_2A-13A	CA_2A-7A-7A	CA_2A-4A-13A
		CA_2A-29A	CA_2A-66A-66A	CA_2A-4A-29A
		CA_2A-30A	CA_2A-66B	CA_2A-12A-30A
		CA_2A-46A	CA_2A-66C	CA_2A-13A-66A
		CA_2A-66A		CA_2A-29A-30A
CA_3A-3A		CA_3A-5A	CA_3A-3A-7A	CA_3A-7A-20A
CA_3C		CA_3A-7A	CA_3C-5A	
		CA_3A-8A	CA_3A-7B	
		CA_3A-19A	CA_3A-7C	
		CA_3A-20A	CA_3A-7A-7A	
		CA_3A-41A	CA_3C-7A	
			CA_3C-20A	
			CA_3A-41C	
CA_4A-4A		CA_4A-5A	CA_4A-4A-5A	CA_4A-5A-30A
		CA_4A-7A	CA_4A-4A-12A	CA_4A-7A-12A
		CA_4A-12A	CA_4A-4A-13A	CA_4A-12A-30A
		CA_4A-13A	CA_4A-4A-30A	CA_4A-29A-30A
		CA_4A-29A	CA_4A-7A-7A	
		CA_4A-30A		
		CA_4A-46A		
		CA_5A-30A	CA_5A-66C	CA_5A-30A-66A
		CA_5A-66A	CA_5A-66A-66A	

Table 1-2: PTCRB Carrier Aggregation Downlink Combinations[a] (Continued)

1 Band/2CC	1 Band/3CC	2 Bands/2CC	2 Bands/3CC	3 Bands/3CC
CA_7B		CA_7A-12A		
CA_7C		CA_7A-20A		
		CA_12A-30A		CA_12A-30A-66A
		CA_12A-66A		
		CA_13A-66A	CA_13A-66A-66A	
			CA_13A-66B [2]	
		CA_20A-32A		
		CA_29A-30A		CA_29A-30A-66A
		CA_29A-66A		
		CA_30A-66A		
	CA_41D			
CA_66B	CA_66A-66B			
CA_66C	CA_66A-66C			

a.   Supported CA DL combinations outside of North America are carrier-dependent.

Table 1-3: Carrier Aggregation Uplink Combinations

CA_3C
CA_7C
CA_41C

Physical Features

- M.2 form factor—WWAN Type 3042-S3-B (in WWAN—USB 3.0 Port Configuration 2), as specified in *[8] PCI Express NGFF (M.2) Electromechanical Specification Revision 1.0*. (Note: Any variations from the specification are detailed in this document.)
- Ambient operating temperature range with appropriate heatsinking:
  - Class A (3GPP compliant): -30°C to +70°C
  - Class B (operational, non-3GPP compliant): -40°C to +85°C (reduced operating parameters required)

Important: *The internal module temperature (reported by AT!PCTEMP) must be kept below 90°C. For best performance, the internal module temperature should be kept below 80°C. Proper mounting, heat sinks, and active cooling may be required, depending on the integrated application.*

Application Interface Features

- USB interface (QMI) for Linux and Android
- MBIM for Windows 8.1, Windows 10, and Linux
- AT command interface (*[1] AT Command Set for User Equipment (UE) (Release 6) (Doc# 3GPP TS 27.007)*, plus proprietary extended AT commands) in *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)*
- Software Development Kits (SDK),including API (Application Program Interface) functions:
  - Windows 8.1, Windows 10
  - Linux
- Support for active antenna control via dedicated antenna control signals (ANTCTL0:3)
- Dynamic power reduction support via software and dedicated GPIO (DPR)

Note: OMA DM and FOTA support is operator-dependent.

- OMA DM (Open Mobile Alliance Device Management)
- FOTA (Firmware Over The Air)

Modem Features

- LTE / DC-HSPA+ / HSPA+ / HSPA / UMTS (WCDMA) operation
- Multiple (up to 16) cellular packet data profiles
- Traditional modem COM port support for AT commands
- USB suspend / resume
- Sleep mode for minimum idle power draw
- SIM application tool kit with proactive SIM commands
- Enhanced Operator Name String (EONS)
- Mobile-originated PDP context activation / deactivation
- Support QoS QCI (3GPP Release 12)
- Static and Dynamic IP address. The network may assign a fixed IP address or dynamically assign one using DHCP (Dynamic Host Configuration Protocol).
- PAP and CHAP support
- PDP context type (IPv4, IPv6, or IPv4v6)
- RFC1144 TCP/IP header compression

LTE Features

- Carrier aggregation:
  - DL LTE-FDD—60 MHz
  - DL LTE-TDD—60 MHz
  - UL LTE—40 MHz intraband contiguous
- CSG support (LTE Femto)
- LTE Advanced receivers (NLIC, eICIC, feICIC)
- Basic cell selection and system acquisition
  - PSS/SSS/MIB decode
  - SIB1–SIB16 decoding
- NAS/AS security procedures
  - Snow 3G/AES/ZUC security
- CQI/RI/PMI reporting

- Paging procedures
  - Paging in Idle and Connected mode
- Dedicated bearer
  - Network-initiated dedicated bearer
  - UE-initiated dedicated bearer
- Multiple PDN connections (IPv4 and IPv6 combinations), subject to operating system support.
- Connected mode intra-LTE mobility
- Idle mode intra-LTE mobility
- iRAT between LTE/3G for idle and connection release with redirection
- Detach procedure
  - Network-initiated detach with reattach required
  - Network-initiated detach followed by connection release

Short Message Service (SMS) Features

- Mobile-originated and mobile-terminated SMS over IMS
- Mobile-originated and mobile-terminated SMS over SGs

Position Location (GNSS)

- Customizable tracking session
- Automatic tracking session on startup
- Concurrent standalone GPS, GLONASS, Galileo, BeiDou, and QZSS
- Assisted GPS (A-GPS) SUPL1.0
- Assisted GPS/GLONASS SUPL2.0
- gpsOneXTRA 1.0/2.0/3.0/3.1
- GNSS reception on dedicated connector or diversity connector

Supporting Documents

Several additional documents describe module design, usage, integration, and other features. See References on page 95.

Accessories

A hardware development kit is available for AirPrime M.2 modules. The kit contains hardware components for evaluating and developing with the module, including:
- Development board
- Cables
- Antennas
- Other accessories

For over-the-air LTE testing, ensure that suitable antennas are used.

Required Connectors

Table 1-4 describes the connectors used to integrate the EM7565 Embedded Module into your host device.

Table 1-4: Required Host-Module Connectors[a]

Connector type	Description
RF cables	• Mate with M.2-spec connectors • Three connector jacks (I-PEX 20448-001R-081 or equivalent)
EDGE (67 pin)	• Slot B compatible—Per the M.2 standard (*[8] PCI Express NGFF (M.2) Electromechanical Specification Revision 1.0*), a generic 75 pin position EDGE connector on the motherboard uses a mechanical key to mate with the 67 pin notched module connector. • Manufacturers include LOTES (part #APCI0018-P001A01), Kyocera, JAE, Tyco, and Longwell.
SIM	• Industry-standard connector. See SIM Interface on page 29 for details.

a. Manufacturers/part numbers are for reference only and are subject to change. Choose connectors that are appropriate for your own design.

Ordering Information

To order, contact the Sierra Wireless Sales Desk at +1 (604) 232-1488 between 8 AM and 5 PM Pacific Time.

Integration Requirements

Sierra Wireless provides, in the documentation suite, guidelines for successful module integration and offers integration support services as necessary.

When integrating the EM7565 Embedded Module, the following items must be addressed:
• **Mounting**—Effect on temperature, shock, and vibration performance
• **Power supply**—Impact on battery drain and possible RF interference
• **Antenna location and type**—Impact on RF performance
• **Regulatory approvals**—As discussed in Regulatory Compliance and Industry Certifications on page 62.
• **Service provisioning**—Manufacturing process
• **Software**—As discussed in Software Interface on page 56.
• **Host interface**—Compliance with interface voltage levels

>> 2: Standards Compliance

The EM7565 Embedded Module complies with the mandatory requirements described in the following standards. The exact set of requirements supported is network operator-dependent.

Table 2-1: Standards Compliance

Technology	Standards
LTE	• 3GPP Release 11[a]
UMTS	• 3GPP Release 9

a. Some auxiliary functions support Release 12 or Release 13.

❯❯|3: Electrical Specifications

The system block diagram in Figure 3-1 represents the EM7565 module integrated into a host system. The module includes the following interfaces to the host:

- Full_Card_Power_Off#—Input supplied to the module by the host—active-low to turn the unit off, or active-high to turn the unit on.
- W_DISABLE#—Active low input from the host to the EM7565 disables the main RF radio.
- GPS_DISABLE#—Active low input from the host to the EM7565 disables the GNSS radio receiver.
- WAKE_ON_WAN#—Active low output used to wake the host when specific events occur.
- WWAN_LED#—Active-low LED drive signal provides an indication of WAN radio ON state.
- RESET#—Active low input from the host used to reset the module.
- Antenna—Three RF connectors (main (Rx/Tx), GNSS, and auxiliary (diversity/MIMO/GNSS)). For details, see RF Specifications on page 37.
- Antenna control—Four signals that can be used to control external antenna switches.
- Dynamic power control—Signal used to adjust Tx power to meet FCC SAR requirements. For details, see Tx Power Control on page 55.).
- Dual SIM—Supported through the interface connector. The SIM cavities / connectors must be placed on the host device for this feature.
- SIM detect—Internal pullup on the module detects whether a SIM is present or not:
    - If a SIM is not inserted, the pin must be shorted to ground.
    - If a SIM is present, the pin will be an open circuit.
- USB—USB 2.0 and USB 3.0 interfaces to the host for data, control, and status information.
- PCIe port—Reserved for future use.

The EM7565 has two main interface areas—the host I/O connector and the RF ports. Details of these interfaces are described in the sections that follow.
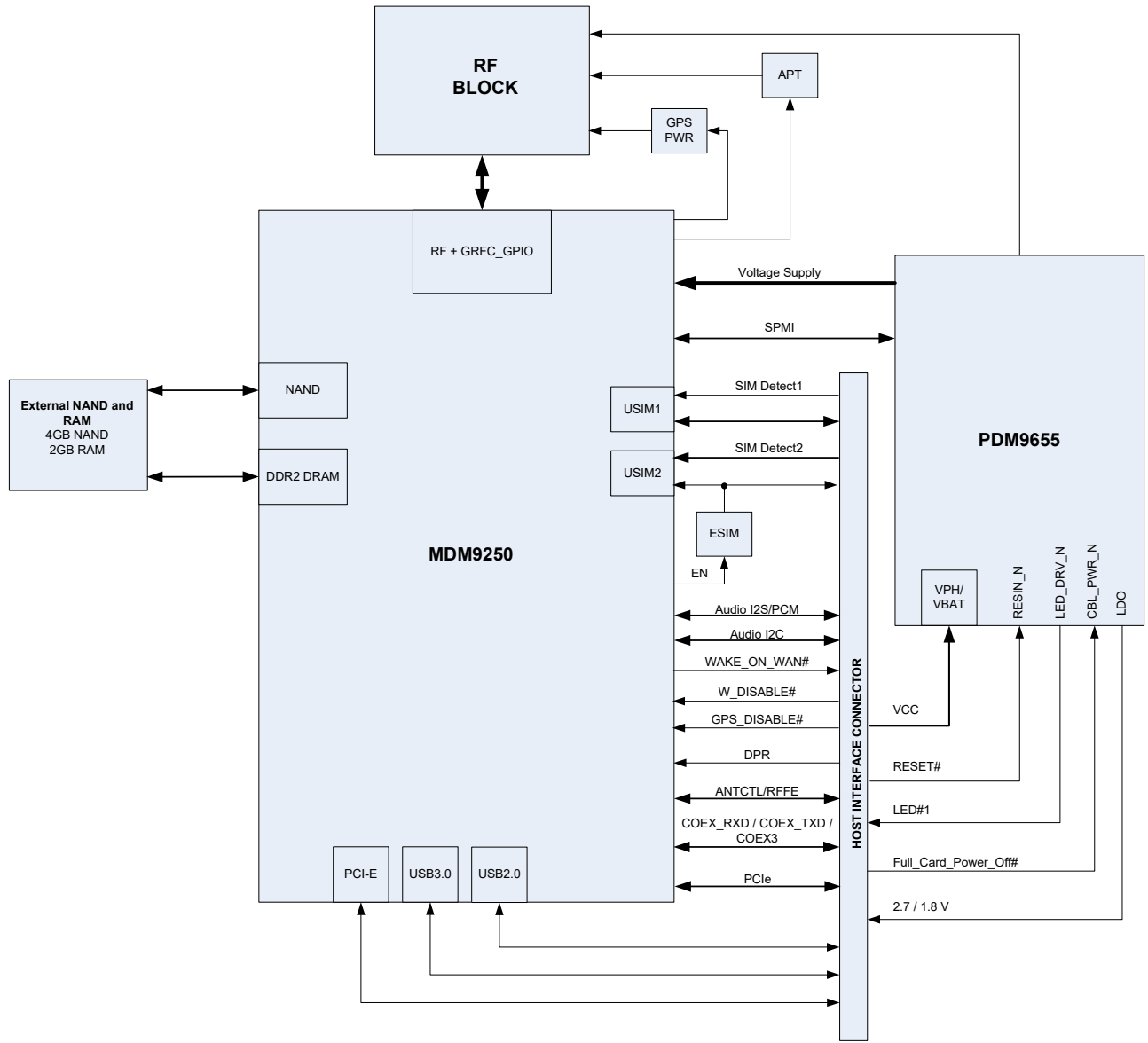
Figure 3-1: System Block Diagram
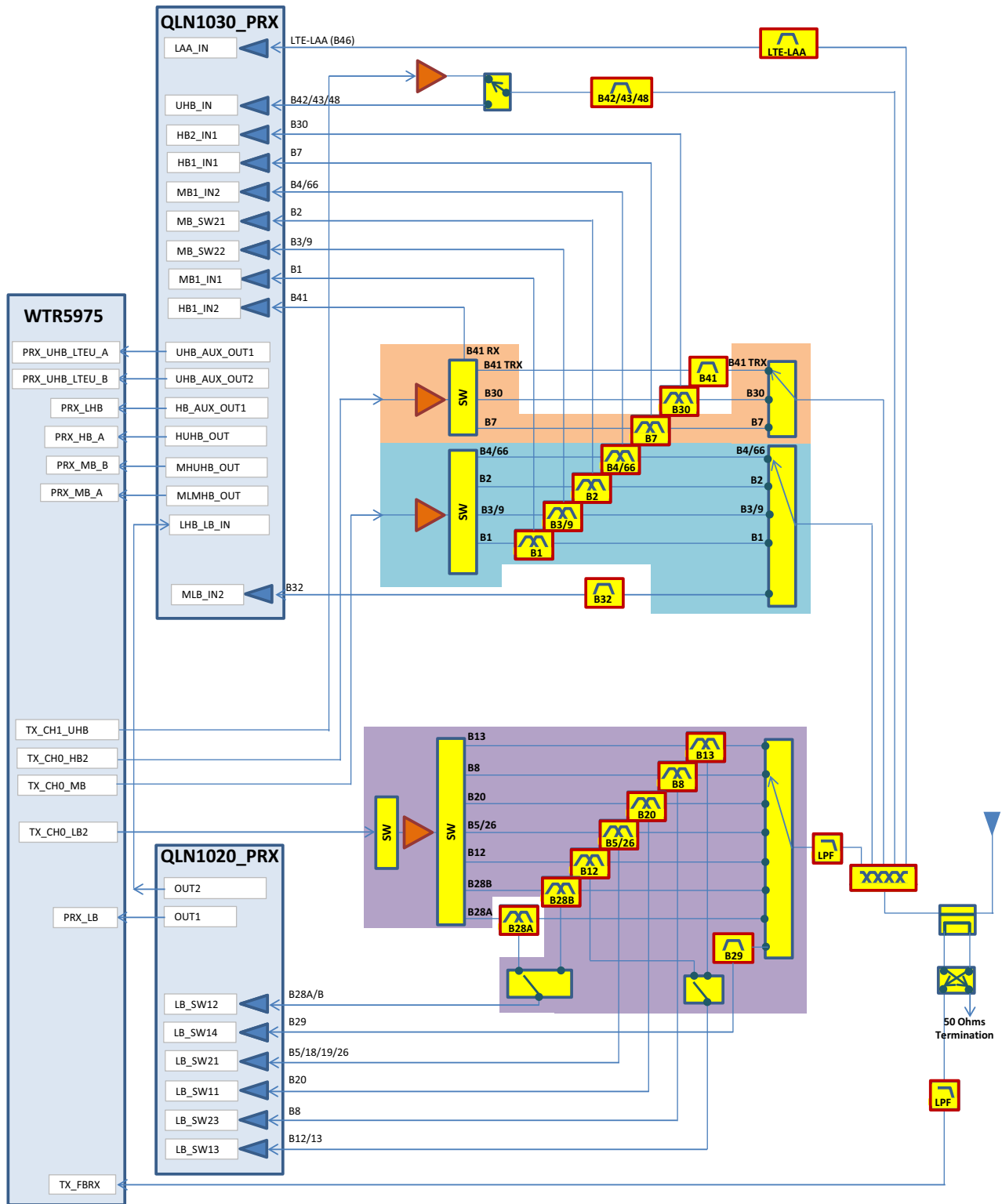
Figure 3-2: Expanded RF (Transmit) Block Diagram
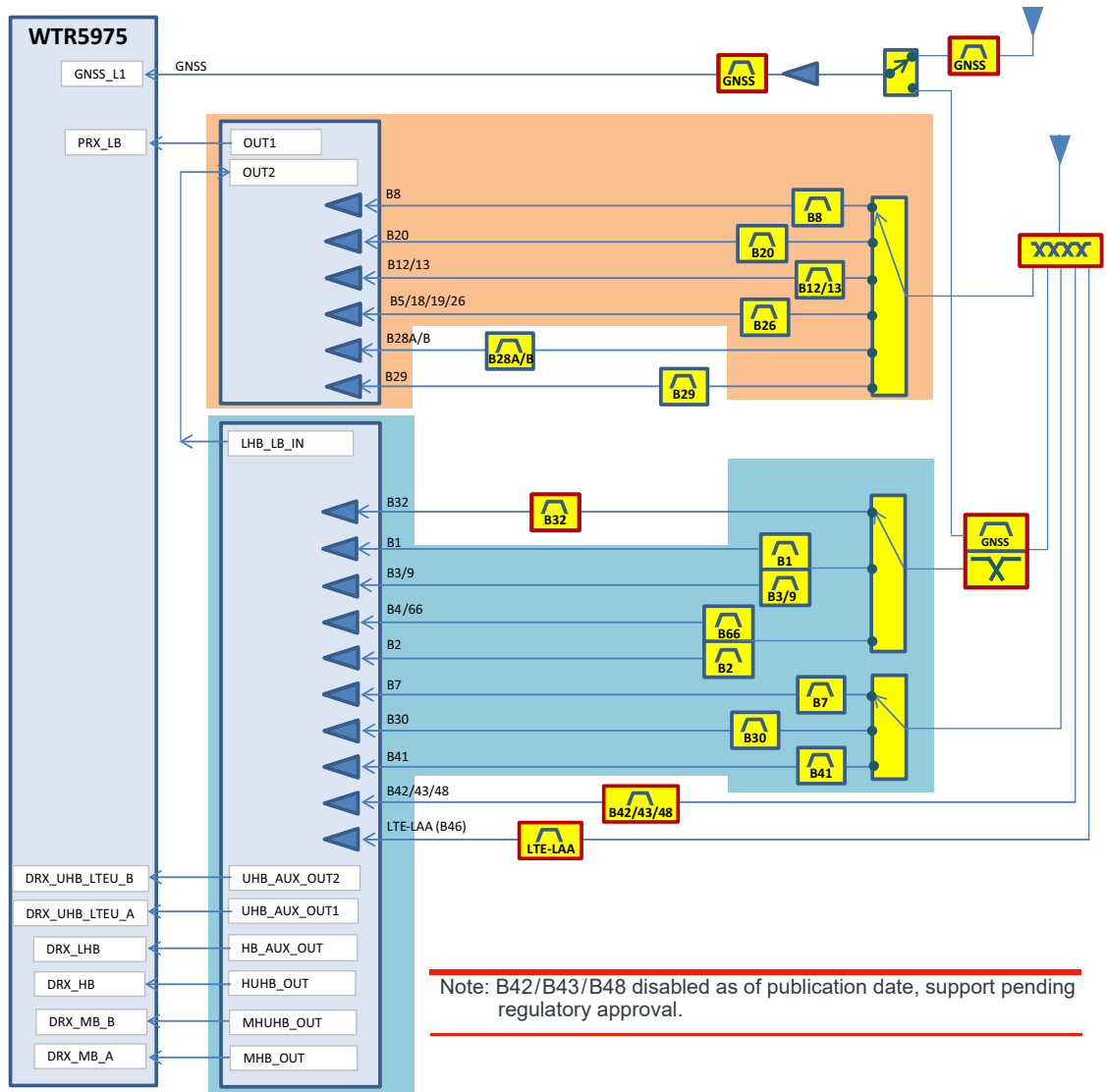
Figure 3-3: Expanded RF (Receive/GNSS) Block Diagram

Host Interface Pin Assignments

The EM7565 host I/O connector provides pins for power, serial communications, and control. Pin assignments are listed in Table 3-1.

Refer to the following tables for pin details based on interface types:

- Table 3-2, Power and Ground Specifications, on page 28
- Table 3-3, USB Interfaces, on page 28
- Table 3-4, SIM Interface Signals, on page 30
- Table 3-5, Module Control Signals, on page 33

Note: On any given interface (USB, SIM, etc.), leave unused inputs and outputs as no-connects.

Note: The host should not drive any signals to the module until >100 ms from the start of the power-on sequence.

Table 3-1: Host Interface (75-pin) Connections — Module View[a]

Pin	Signal name	Pin type[b]	Description	Direction[c]	Active state	Voltage levels (V) Min	Typ	Max
1	CONFIG_3 (NC in default module configuration)		Reserved—Host must not repurpose this pin.					
2	VCC	V	Power source	Input	Power	3.135	3.3	4.4
3	GND	V	Ground	Input	Power	-	0	-
4	VCC	V	Power source	Input	Power	3.135	3.3	4.4
5	GND	V	Ground	Input	Power	-	0	-
6	Full_Card_Power_Off#[d]	PD	Turn modem on	Input	High	0.7	-	4.4
			Turn modem off	Input	Low	-0.3	-	0.5
7	USB_D+[d]	-	USB data positive	Input/Output	Differential	-	-	-
8	W_DISABLE#[e]	PU	Wireless Disable (main RF radio)	Input	Low	-	-	0.4
				Input	High	0.7	-	4.4
9	USB_D-[d]	-	USB data negative	Input/Output	Differential	-	-	-
10	WWAN_LED#	OC	LED Driver	Output	Low	0	-	0.15
11	GND	V	Ground	Input	Power	-	0	-
12	Key	Notch location						
13	Key	Notch location						
14	Key	Notch location						
15	Key	Notch location						
16	Key	Notch location						
17	Key	Notch location						
18	Key	Notch location						
19	Key	Notch location						
20	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved—Host must not repurpose this pin.					

Table 3-1: Host Interface (75-pin) Connections — Module View[a] (Continued)

Pin	Signal name	Pin type[b]	Description	Direction[c]	Active state	Voltage levels (V)		
						Min	Typ	Max
21	CONFIG_0 (GND in default module configuration)		Reserved—Host must not repurpose this pin.	Output	-		0	
22	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved—Host must not repurpose this pin.					
23	WAKE_ON_WAN#[d]	OC	Wake Host	Output	Low	0		0.1
24	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved—Host must not repurpose this pin.					
25	DPR	-	Dynamic power control	Input	High	1.17	1.80	2.10
				Input	Low	-0.3	-	0.63
26	GPS_DISABLE#[e]	PU	Wireless disable (GNSS radio)	Input	Low	-	-	0.4
				Input	High	0.7	-	4.4
27	GND	V	Ground	Input	Power	-	0	-
28	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved—Host must not repurpose this pin.					
29	USB3.0_TX-		USB 3.0 Transmit Data negative	Output	Differential	-	-	-
30	UIM1_RESET[d]	O	SIM Reset	Output	Low	0	-	0.45
					High	2.55 (3V SIM) 1.35 (1.8V SIM)	3.00 (3V SIM) 1.80 (1.8V SIM)	3.10 (3V SIM) 1.90 (1.8V SIM)
31	USB3.0_TX+		USB 3.0 Transmit Data positive	Output	Differential	-	-	-
32	UIM1_CLK[d]	O	SIM Clock	Output	Low	0	-	0.45
					High	2.55 (3V SIM) 1.35 (1.8V SIM)	3.00 (3V SIM) 1.80 (1.8V SIM)	3.10 (3V SIM) 1.90 (1.8V SIM)
33	GND	V	Ground	Input	Power	-	0	-

Table 3-1: Host Interface (75-pin) Connections—Module View[a] (Continued)

Pin	Signal name	Pin type[b]	Description	Direction[c]	Active state	Voltage levels (V)		
						Min	Typ	Max
34	UIM1_DATA[d]	-	SIM IO pin	Input	Low	-0.30 (3V SIM)	-	0.60 (3V SIM)
						-0.30 (1.8V SIM)		0.35 (1.8V SIM)
					High	2.10 (3V SIM)	3.00 (3V SIM)	3.30 (3V SIM)
						1.17 (1.8V SIM)	1.80 (1.8V SIM)	2.10 (1.8V SIM)
				Output	Low	0	-	0.40
					High	2.55 (3V SIM)	3.00 (3V SIM)	3.10 (3V SIM)
						1.35 (1.8V SIM)	1.80 (1.8V SIM)	1.90 (1.8V SIM)
35	USB3.0_RX-		USB 3.0 Receive Data negative	Input	Differential	-	-	-
36	UIM1_PWR[d]	V	SIM VCC supply	Output	Power	2.90 (3V SIM)	3.00 (3V SIM)	3.10 (3V SIM)
						1.75 (1.8V SIM)	1.80 (1.8V SIM)	1.85 (1.8V SIM)
37	USB3.0_RX+		USB 3.0 Receive Data positive	Input	Differential	-	-	-
38	NC		Reserved					
39	GND	V	Ground	Input	Power	-	0	-
40	SIM_DETECT_2		SIM2 indication	Input	0 V—SIM not present Open circuit—SIM present			
41	PCIE_TXM		PCIe Negative Transmit Data	Output	Differential	-	-	-
42	UIM2_DATA[d]	-	SIM2 IO pin	Input	Low	-0.30 (3V SIM)	-	0.60 (3V SIM)
						-0.30 (1.8V SIM)		0.35 (1.8V SIM)
					High	2.10 (3V SIM)	3.00 (3V SIM)	3.30 (3V SIM)
						1.17 (1.8V SIM)	1.80 (1.8V SIM)	2.10 (1.8V SIM)
				Output	Low	0	-	0.40
					High	2.55 (3V SIM)	3.00 (3V SIM)	3.10 (3V SIM)
						1.35 (1.8V SIM)	1.80 (1.8V SIM)	1.90 (1.8V SIM)
43	PCIE_TXP		PCIe Positive Transmit Data	Output	Differential	-	-	-

Table 3-1: Host Interface (75-pin) Connections — Module View[a] (Continued)

Pin	Signal name	Pin type[b]	Description	Direction[c]	Active state	Voltage levels (V)		
						Min	Typ	Max
44	UIM2_CLK[d]	O	SIM2 Clock	Output	Low	0	-	0.45
					High	2.55 (3V SIM) 1.35 (1.8V SIM)	3.00 (3V SIM) 1.80 (1.8V SIM)	3.10 (3V SIM) 1.90 (1.8V SIM)
45	GND	V	Ground	Input	Power	-	0	-
46	UIM2_RESET[d]	O	SIM2 Reset	Output	Low	0	-	0.45
					High	2.55 (3V SIM) 1.35 (1.8V SIM)	-	3.10 (3V SIM) 1.90 (1.8V SIM)
47	PCIE_RXM		PCIe Negative Receive Data	Input	Differential	-	-	-
48	UIM2_PWR[d]	V	SIM2 VCC supply	Output	Power	2.90 (3V SIM) 1.75 (1.8V SIM)	3.00 (3V SIM) 1.80 (1.8V SIM)	3.10 (3V SIM) 1.85 (1.8V SIM)
49	PCIE_RXP		PCIe Positive Receive Data	Input	Differential	-	-	-
50	PCIE_PERST_N		PCIe Reset	Input	Low	0	-	0.7
				Input	High	1.5	-	VCC
51	GND	V	Ground	Input	Power	-	0	-
52	PCIE_CLKREQ_N	OC	PCIe Clock Request	Output	Low	0	-	0.35
53	PCIE_REFCLKM		PCIe Negative Reference Clock	Input	Differential	-	-	-
54	PCIE_PEWAKE_N	OC	PCIe Wake	Output	Low	0	-	0.35
55	PCIE_REFCLKP		PCIe Positive Reference Clock	Input	Differential	-	-	-
56	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved — Host must not repurpose this pin.					
57	GND	V	Ground	Input	Power	-	0	-
58	NC (For audio interface pin usage, see Audio Support on page 65.)		Reserved — Host must not repurpose this pin.					
59	ANTCTL0 (GPIO1)		Customer-defined external switch control for multiple antennas	Output	High	1.35	-	1.80
				Output	Low	0	-	0.45
60	Reserved — Host must not repurpose this pin and should leave it not connected.							

Table 3-1: Host Interface (75-pin) Connections—Module View[a] (Continued)

Pin	Signal name	Pin type[b]	Description	Direction[c]	Active state	Voltage levels (V)		
						Min	Typ	Max
61	ANTCTL1 (GPIO2)		Customer-defined external switch control for multiple antennas	Output	High	1.35	-	1.80
				Output	Low	0	-	0.45
62	Reserved—Host must not repurpose this pin and should leave it not connected.							
63	ANTCTL2 (GPIO3)		Customer-defined external switch control for multiple antennas	Output	High	1.35	-	1.80
				Output	Low	0	-	0.45
64	Reserved—Host must not repurpose this pin and should leave it not connected.							
65	ANTCTL3 (GPIO4)		Customer-defined external switch control for multiple antennas	Output	High	1.35	-	1.80
				Output	Low	0	-	0.45
66	SIM_DETECT[d]	PU	SIM indication	Input		0 V—SIM not present Open circuit—SIM present		
67	RESET#	PU	Reset module	Input	Low	-0.3		0.63
68	NC		Reserved					
69	CONFIG_1 (GND in default module configuration)		Reserved—Host must not repurpose this pin.	Output	-		0	
70	VCC	V	Power source	Input	Power	3.135	3.3	4.4
71	GND	V	Ground	Input	Power	-	0	-
72	VCC	V	Power source	Input	Power	3.135	3.3	4.4
73	GND	V	Ground	Input	Power	-	0	-
74	VCC	V	Power source	Input	Power	3.135	3.3	4.4
75	CONFIG_2 (NC in default module configuration)	V	Reserved	Output	-	-		-

a. All values are preliminary and subject to change.
b. I—Input; O—Digital output; OC—Open Collector output; PU—Digital input (internal pull up); PD—Digital input (internal pull down); V—Power or ground
c. Signal directions are from module's point of view (e.g. 'Output' from module to host, 'Input' to module from host.)
d. Required signal
e. Sierra Wireless recommends that the host implement an open collector driver where a Low signal will turn the module off or enter low power mode, and a high signal will turn the module on or leave low power mode.

Power Supply

The host provides power to the EM7565 through multiple power and ground pins as summarized in Table 3-2.

The host must provide safe and continuous power (via battery or a regulated power supply) at all times; the module does not have an independent power supply, or protection circuits to guard against electrical issues.

Table 3-2: Power and Ground Specifications

Name	Pins	Specification	Min	Typ	Max	Units
VCC (3.3V)	2, 4, 70, 72, 74	Voltage range	See Table 3-1 on page 23.			
		Ripple voltage	-	-	100	mV_{pp}
GND	3, 5, 11, 27, 33, 39, 45, 51, 57, 71, 73	-	-	0	-	V

USB Interface

Important: *Host support for USB 2.0 or USB 3.0 signals is required.*

The device supports USB 2.0 and USB 3.0 interfaces for communication between the host and module.

The interfaces comply with the *[9] Universal Serial Bus Specification, Rev 2.0* and *[10] Universal Serial Bus Specification, Rev 3.0* (subject to limitations described below), and the host device must be designed to the same standards.

Table 3-3: USB Interfaces

	Name	Pin	Description
USB 2.0	USB_D+	7	Data positive
	USB_D-	9	Data negative
USB 3.0	USB3.0-TX-[a]	29	Transmit data negative
	USB3.0-TX+[a]	31	Transmit data positive
	USB3.0-RX-[a]	35	Receive data negative
	USB3.0-RX+[a]	37	Receive data positive

a. Signal directions (Tx/Rx) are from module's point of view.

Host-side Recommendation

Note: When designing the host device, careful PCB layout practices must be followed.

Sierra Wireless recommends the host platform include series capacitors on the USB3.0 Rx signals (no capacitors required for the Tx signals), as shown below.
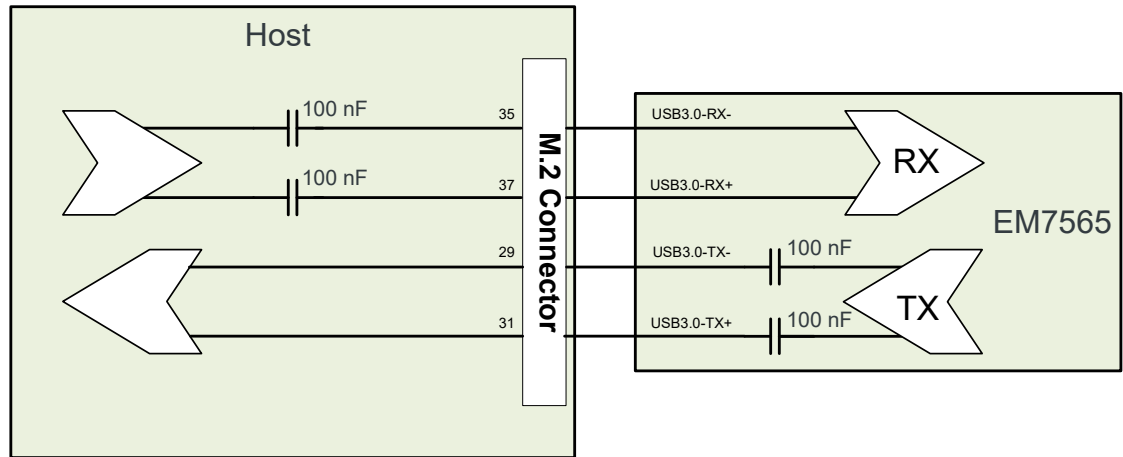

Figure 3-4: Recommended Capacitor Placement for USB3.0 Signals

USB Throughput Performance

This device has been designed to achieve optimal performance and maximum throughput using USB superspeed mode (USB 3.0). Although the device may operate with a high speed host, throughput performance will be on an "as is" basis and needs to be characterized by the OEM. Note that throughput will be reduced and may vary significantly based on packet size, host interface, and firmware revision.

User-developed Drivers

Details for user-developed USB drivers are described in *[4] AirCard/AirPrime USB Driver Developer's Guide (Doc# 2130634).*

SIM Interface

Note: Host support for SIM interface signals is required.

The module supports up to two SIMs (Subscriber Identity Module) (1.8 V or 3 V). Each SIM holds information for a unique account, allowing users to optimize their use of each account on multiple devices.

The SIM pins (Table 3-4 on page 30) provide the connections necessary to interface to SIM sockets located on the host device as shown in Figure 3-5 on page 31. Voltage levels over this interface comply with 3GPP standards.

The types of SIM connectors used depends on how the host device exposes the SIM sockets.

Table 3-4: SIM Interface Signals

| SIM	Name	Pin	Description	SIM contact[a]	Notes
Primary	UIM1_RESET	30	Reset	2	Active low SIM reset
	UIM1_CLK	32	Serial clock	3	Serial clock for SIM data
	UIM1_DATA	34	Data I/O	7	Bi-directional SIM data line
	UIM1_PWR	36	SIM voltage	1	Power supply for SIM
	SIM_DETECT	66	SIM indication	-	Input from host indicating whether SIM is present or not • Grounded if no SIM is present • No-connect (floating) if SIM is inserted
	UIM_GND		Ground	5	Ground reference UIM_GND is common to module ground
Secondary	UIM2_RESET	46	Reset	2	Active low SIM reset
	UIM2_CLK	44	Serial clock	3	Serial clock for SIM data
	UIM2_DATA	42	Data I/O	7	Bi-directional SIM data line
	UIM2_PWR	48	SIM voltage	1	Power supply for SIM
	SIM_DETECT_2	40	SIM indication	-	Input from host indicating whether SIM is present or not • Grounded if no SIM is present • No-connect (floating) if SIM is inserted
	UIM2_GND		SIM indication	-	Ground reference UIM2_GND is common to module ground

a. See Figure 3-6 on page 31 for SIM card contacts.
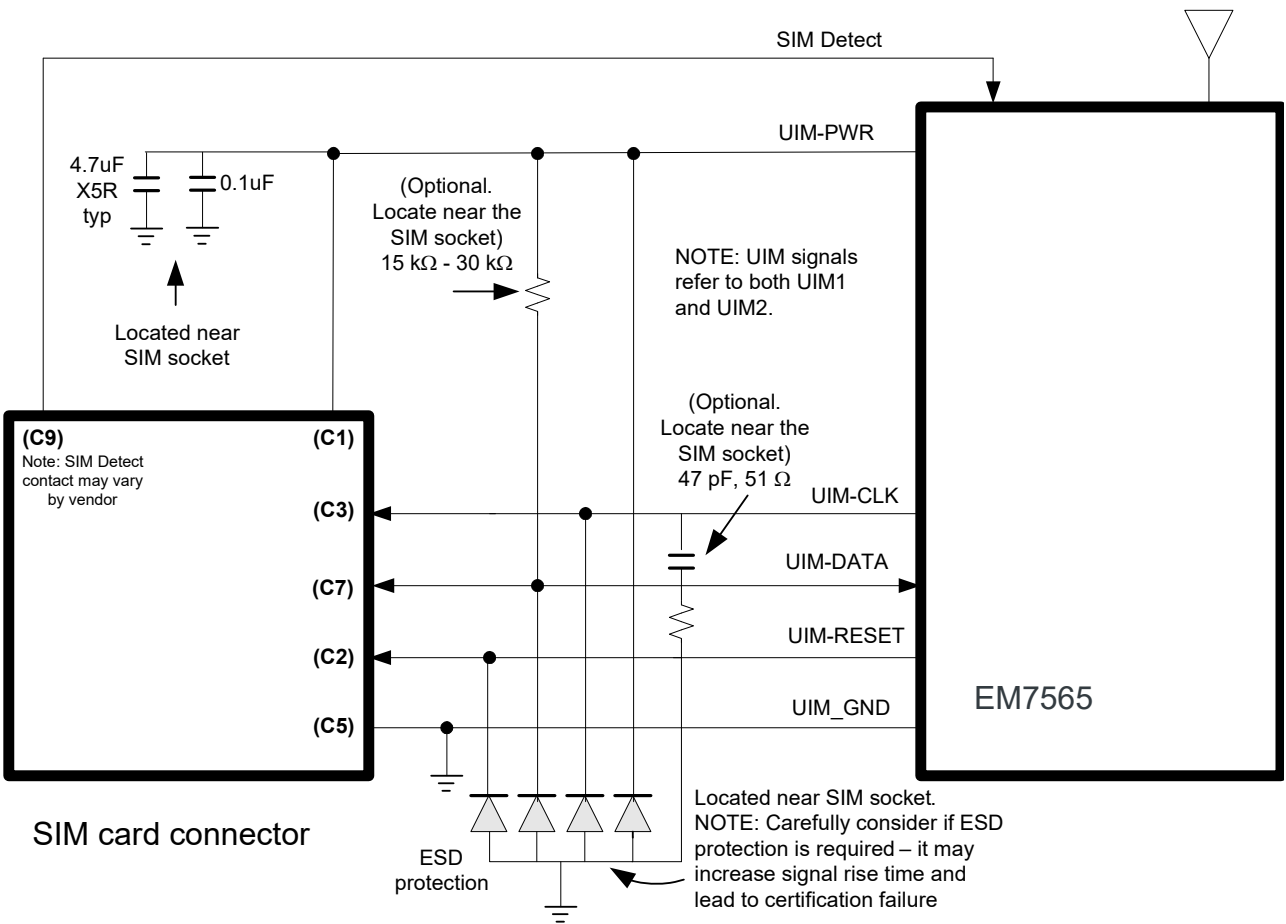
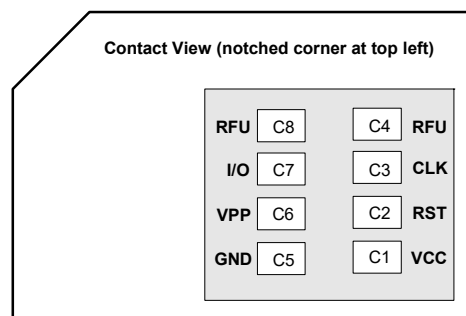*Figure 3-5: SIM Application Interface (applies to both SIM interfaces)*

Figure 3-6: SIM Card Contacts (Contact View)

SIM Implementation

When designing the remote SIM interface, you *must* make sure that SIM signal integrity is not compromised.

Some design recommendations include:
- Total impedance of the VCC and GND connections to the SIM, measured at the module connector, should be less than 1 Ω to minimize voltage drop (includes any trace impedance and lumped element components—inductors, filters, etc.).
- Position the SIM connector ≤10 cm from the module. If a longer distance is required because of the host device design, use a shielded wire assembly— connect one end as close as possible to the SIM connector and the other end as close as possible to the module connector. The shielded assembly may help shield the SIM interface from system noise.
- Reduce crosstalk on the UIM1_DATA and UIM2_DATA lines to reduce the risk of failures during GCF approval testing.
- Avoid routing the clock and data lines for each SIM (UIM1_CLK/UIM1_DATA, UIM2_CLK/UIM2_DATA) in parallel over distances >2 cm—cross-coupling of a clock and data line pair can cause failures.
- 3GPP has stringent requirements for I/O rise time (<1 μs), signal level limits, and noise immunity—consider this carefully when developing your PCB layout.
  - Keep signal rise time <1 μs—keep SIM signals as short as possible, and keep very low capacitance traces on the data and clock signals (UIM1_CLK, UIM1_DATA, UIM2_CLK, UIM2_DATA). High capacitance increases signal rise time, potentially causing your device to fail certification tests.
- Add external pull-up resistors (15 kΩ–30 kΩ), if required, between the data and power lines for each SIM (UIM1_DATA/UIM1_PWR, UIM2_DATA/UIM2_PWR) to optimize the signal rise time.
- VCC line should be decoupled close to the SIM socket.
- SIM is specified to run up to 5 MHz (SIM clock rate). Take note of this speed in the placement and routing of the SIM signals and connectors.
- You must decide whether additional ESD protection is required for your product, as it is dependent on the application, mechanical enclosure, and SIM connector design. The SIM pins will require additional ESD protection if they are exposed to high ESD levels (i.e. can be touched by a user).
- Putting optional decoupling capacitors on the SIM power lines (UIM1_PWR, UIM2_PWR) near the SIM sockets is recommended—the longer the trace length (impedance) from the socket to the module, the greater the capacitance requirement to meet compliance tests.
- Putting an optional series capacitor and resistor termination (to ground) on the clock lines (UIM1_CLK, UIM2_CLK) at the SIM sockets to reduce EMI and increase signal integrity is recommended if the trace length between the SIM socket and module is long—47 pF and 50 Ω resistor are recommended.
- Test your first prototype host hardware with a Comprion IT[3] SIM test device at a suitable testing facility.

Control Interface (Signals)

The EM7565 provides signals for:
- Waking the host when specific events occur

- Host control of the module's radios
- Host control of module power
- LED driver output

These signals are summarized in Table 3-5 and paragraphs that follow.

Table 3-5: Module Control Signals

Name	Pin	Description	Type[a]
Full_Card_Power_Off#	6	On/off signal	PD
W_DISABLE#	8	Wireless disable (Main RF)	PU
WWAN_LED#	10	LED driver	OC
WAKE_ON_WAN#	23	Wake host	O
GPS_DISABLE#	26	Wireless disable (GNSS)	PU
RESET#	67	Reset module	PU

    a.   O—Digital pin Output; OC—Open Collector output; PD—Digital pin Input, internal pull down; PU—Digital pin Input, internal pull up

WAKE_ON_WAN# — Wake Host

The EM7565 uses WAKE_ON_WAN# to wake the host when specific events occur.

The host must provide a 5 kΩ–100 kΩ pullup resistor that considers total line capacitance (including parasitic capacitance) such that when WAKE_ON_WAN# is deasserted, the line will rise to 3.3 V (Host power rail) in < 100 ns.

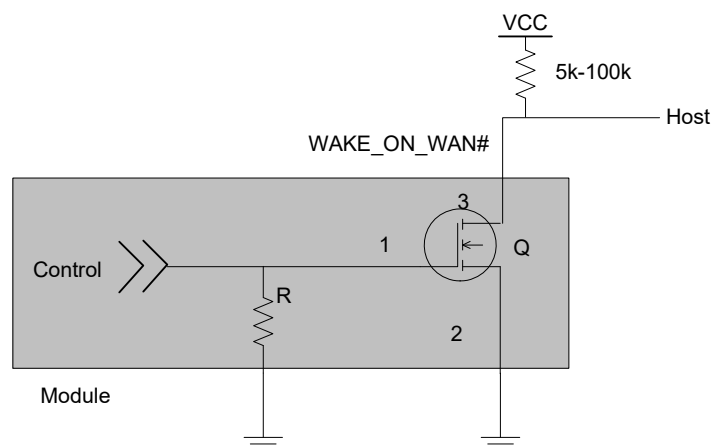See Figure 3-7 on page 33 for a recommended implementation.

Figure 3-7: Recommended WAKE_ON_WAN# Connection

W_DISABLE# (Wireless Disable) and GPS_DISABLE# (GNSS Disable)

The host device uses W_DISABLE# to enable/disable the WWAN or radio modem, and GPS_DISABLE# to enable/disable GNSS functionality.

Letting these signals float high allows the module to operate normally. These pins have 100 kΩ pull-up resistors. See Figure 3-8 on page 34 for a recommended implementation.

When integrating with your host device, keep the following in mind:
- The signal is an input to the module and should be driven LOW to turn the radio off, or HIGH or floating to keep it on.
- If the host never needs to assert this power state control to the module, leave this signal unconnected from the host interface.

Table 3-6: W_DISABLE# / GPS_DISABLE# Usage

Name	Pin	Description / notes
W_DISABLE#	8	Enable/disable the WWAN or radio modem[a]. When disabled, the modem cannot transmit or receive. • Leave as not connected or drive HIGH to keep the modem always on. • Drive LOW to turn the modem off.
GPS_DISABLE#	26	Enable/disable GNSS functionality[a] • Leave as not connected or drive HIGH to enable GNSS functionality. • Drive LOW to disable GNSS functionality. • For details on enabling / disabling GNSS functionality, see the AT!CUSTOM="GPSENABLE" command in *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748).*

a. Sierra Wireless recommends that the host implement an open collector driver where a Low signal turns off the modem or disables GNSS functionality, and a high signal turns on the modem or len-ables GNSS functionality.
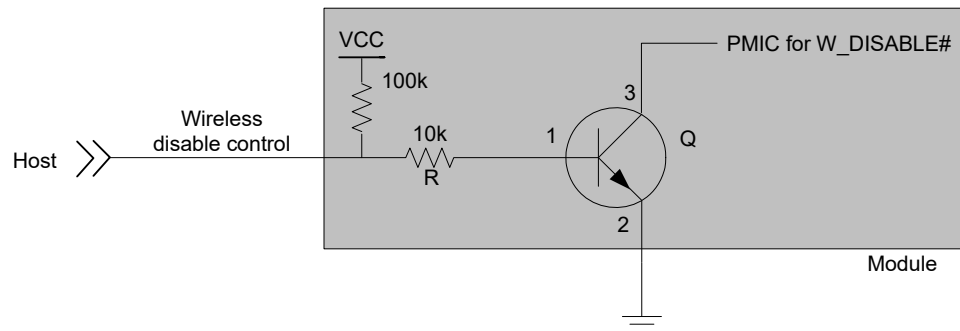

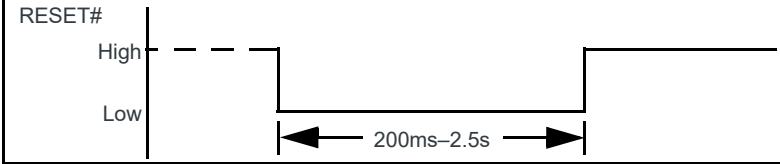*Figure 3-8: Recommended Wireless Disable Connection*

Full_Card_Power_Off# and RESET#

Full_Card_Power_Off# and RESET# are inputs to the module that the host uses as described in Table 3-7.

For timing details, see Power On/Off Timing for the USB on page 53.

Table 3-7: Full_Card_Power_Off# and RESET# Usage

Name	Pin	Description/notes

Full_Card_Power_Off#	6	Powers the module on/off.
		• Signal is required.
		• Pull HIGH to keep the module on. To keep the module always on:
		  • Tie the pin directly to a host GPIO (1.8V), or
		  • Use an external pull-up to pull signal high (10k–20k for 1.8V, 75–100k for VCC rail). Note that a larger-value resistor will reduce leakage current.
		• To power off the module, see Required Shutdown Sequence on page 54.

RESET#	67	Resets the module. • Signal is optional. The module will operate correctly if the pin is left disconnected on the host. • To reset the module, pulse the RESET# pin with a logic low signal for 200 ms (min) to 2.5 seconds (max)—if the signal is held low for more than 2.5 seconds, the reset cycle restarts, and if it is held low through several cycles, the module will not fully boot. Otherwise, leave the signal floating or high impedance (the module will remain operational because the module has a pull-up resistor to an internal reference voltage (1.8V) in place.). RESET# High ———— ⌐‾‾⌐ Low ◄——— 200ms–2.5s ———► • The signal requires an open collector input from the host. • This is a 'hard' reset, which should be used only if the host cannot communicate with the module via the USB port. (If the port is not working, the module may have locked up or crashed.) **Caution:** *RESET# should not be driven or pulled to a logic high level by the host, as this may cause damage to the module.*

WWAN_LED#—LED Output

The configuration for the LED shown in Figure 3-9 is customizable. Contact your Sierra Wireless account representative for details.
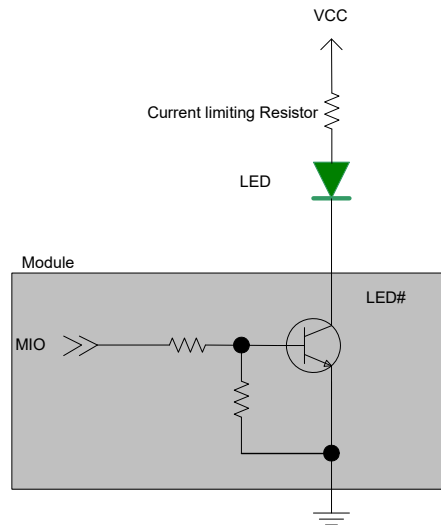
Figure 3-9: Example LED

Antenna Control

The EM7565 provides four output signals (listed in Table 3-8) that may be used for host designs that incorporate tunable antennas. Customers can configure these signals as appropriate for the operating band(s) using the command AT!ANTSEL. (See *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)* for details.)

Note: To avoid detuning the PCC band, customers must make sure there are no GPIO state conflicts between the PCC and SCC for all supported CA combinations.

Table 3-8: Antenna Control Signals

Name	Pin	Description
ANTCTL0	59	Customer-defined external switch controls for tunable antennas
ANTCTL1	61	
ANTCTL2	63	
ANTCTL3	65	

≫|4: RF Specifications

The EM7565 includes three RF connectors for use with host-supplied antennas:
- Main RF connector—Tx/Rx path
- GNSS RF connector—Dedicated GPS, GLONASS, BeiDou, Galileo, and QZSS
- Auxiliary RF connector—Diversity, MIMO, GPS, GLONASS, BeiDou, Galileo, and QZSS

The module does not have integrated antennas.
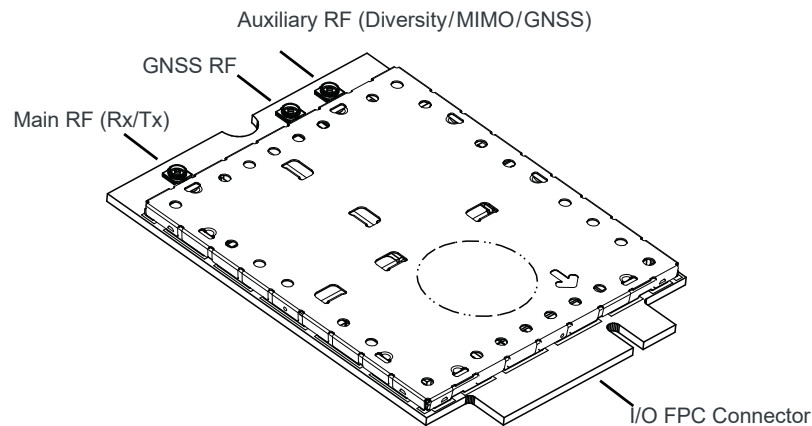
Figure 4-1: Module Connectors

RF Connections

When attaching antennas to the module:
- Use RF plug connectors that are compatible with the following RF receptacle connectors: Foxconn (KK12011-02-7H), Longwell (911-002-0006R), Speedtech (C87P101-00001-H), Murata (MM4829-2702RA4 (HSC)), IPEX (20449-001E (MHF4)).
- Match coaxial connections between the module and the antenna to 50 Ω.
- Minimize RF cable losses to the antenna; the recommended maximum cable loss for antenna cabling is 0.5 dB.
- To ensure best thermal performance, use the mounting hole (if possible) to attach (ground) the device to a metal chassis.

Note: If the antenna connection is shorted or open, the modem will not sustain permanent damage.

Shielding

The module is fully shielded to protect against EMI and must not be removed.

Antenna and Cabling

When selecting the antenna and cable, it is critical to RF performance to match antenna gain and cable loss.

Note: For detailed electrical performance criteria, see Appendix B: Antenna Specification on page 69.

Choosing the Correct Antenna and Cabling

When matching antennas and cabling:
- The antenna (and associated circuitry) should have a nominal impedance of 50 Ω with a return loss of better than 10 dB across each frequency band of operation.
- The system gain value affects both radiated power *and* regulatory (FCC, IC, CE, etc.) test results.

Designing Custom Antennas

Consider the following points when designing custom antennas:
- A skilled RF engineer should do the development to ensure that the RF performance is maintained.
- If both UMTS and CDMA modules will be installed in the same platform, you may want to develop separate antennas for maximum performance.

Determining the Antenna's Location

When deciding where to put the antennas:
- Antenna location may affect RF performance. Although the module is shielded to prevent interference in most applications, the placement of the antenna is still very important—if the host device is insufficiently shielded, high levels of broadband or spurious noise can degrade the module's performance.
- Connecting cables between the module and the antenna must have 50 Ω impedance. If the impedance of the module is mismatched, RF performance is reduced significantly.
- Antenna cables should be routed, if possible, away from noise sources (switching power supplies, LCD assemblies, etc.). If the cables are near the noise sources, the noise may be coupled into the RF cable and into the antenna. See Interference from Other Wireless Devices on page 39.

Disabling the Diversity Antenna

Certification testing of a device with an integrated EM7565 may require the module's main and diversity antennas to be tested separately.

To facilitate this testing, receive diversity can be enabled/disabled using AT commands:
- !RXDEN—Used to enable/disable diversity for single-cell call (no carrier aggregation).
- !LTERXCONTROL—Used to enable/disable paths (in carrier aggregation scenarios) after a call is set up.

Important: *LTE networks expect modules to have more than one antenna enabled for proper operation. Therefore, customers must not commercially deploy their systems with the diversity antenna disabled.*

For details, see *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)*.

Note: A diversity antenna is used to improve connection quality and reliability through redundancy. Because two antennas may experience difference interference effects (signal distortion, delay, etc.), when one antenna receives a degraded signal, the other may not be similarly affected.

Ground Connection

When connecting the module to system ground:
- Prevent noise leakage by establishing a very good ground connection to the module through the host connector.
- Connect to system ground using the mounting hole shown in Figure 4-1 on page 37.
- Minimize ground noise leakage into the RF.
  Depending on the host board design, noise could *potentially* be coupled to the module from the host board. This is mainly an issue for host designs that have signals traveling along the length of the module, or circuitry operating at both ends of the module interconnects.

Interference and Sensitivity

Several interference sources can affect the module's RF performance (RF desense). Common sources include power supply noise and device-generated RF.

RF desense can be addressed through a combination of mitigation techniques (Methods to Mitigate Decreased Rx Performance on page 40) and radiated sensitivity measurement (Radiated Sensitivity Measurement on page 41).

Note: The EM7565 is based on ZIF (Zero Intermediate Frequency) technologies. When performing EMC (Electromagnetic Compatibility) tests, there are no IF (Intermediate Frequency) components from the module to consider.

Interference from Other Wireless Devices

Wireless devices operating inside the host device can cause interference that affects the module.

To determine the most suitable locations for antennas on your host device, evaluate each wireless device's radio system, considering the following:
- Any harmonics, sub-harmonics, or cross-products of signals generated by wireless devices that fall in the module's Rx range may cause spurious response, resulting in decreased Rx performance.

- The Tx power and corresponding broadband noise of other wireless devices may overload or increase the noise floor of the module's receiver, resulting in Rx desense.

The severity of this interference depends on the closeness of the other antennas to the module's antenna. To determine suitable locations for each wireless device's antenna, thoroughly evaluate your host device's design.

Host-generated RF Interference

All electronic computing devices generate RF interference that can negatively affect the receive sensitivity of the module.

Proximity of host electronics to the antenna in wireless devices can contribute to decreased Rx performance. Components that are most likely to cause this include:
- Microprocessor and memory
- Display panel and display drivers
- Switching-mode power supplies

Device-generated RF Interference

The module can cause interference with other devices. Wireless devices such as AirPrime embedded modules transmit in bursts (pulse transients) for set durations (RF burst frequencies). Hearing aids and speakers convert these burst frequencies into audible frequencies, resulting in audible noise.

Methods to Mitigate Decreased Rx Performance

It is important to investigate sources of localized interference early in the design cycle. To reduce the effect of device-generated RF on Rx performance:
- Put the antenna as far as possible from sources of interference. The drawback is that the module may be less convenient to use.
- Shield the host device. The module itself is well shielded to avoid external interference. However, the antenna cannot be shielded for obvious reasons. In most instances, it is necessary to employ shielding on the components of the host device (such as the main processor and parallel bus) that have the highest RF emissions.
- Filter out unwanted high-order harmonic energy by using discrete filtering on low frequency lines.
- Form shielding layers around high-speed clock traces by using multi-layer PCBs.
- Route antenna cables away from noise sources.

Radiated Spurious Emissions (RSE)

When designing an antenna for use with AirPrime embedded modules, the host device with an AirPrime embedded module must satisfy any applicable standards/ local regulatory bodies for radiated spurious emission (RSE) for receive-only mode and for transmit mode (transmitter is operating).

Note that antenna impedance affects radiated emissions, which must be compared against the conducted 50-ohm emissions baseline. (AirPrime embedded modules meet the 50-ohm conducted emissions requirement.)

Radiated Sensitivity Measurement

A wireless host device contains many noise sources that contribute to a reduction in Rx performance.

To determine the extent of any receiver performance desensitization due to self-generated noise in the host device, over-the-air (OTA) or radiated testing is required. This testing can be performed by Sierra Wireless or you can use your own OTA test chamber for in-house testing.

Sierra Wireless' Sensitivity Testing and Desensitization Investigation

Although AirPrime embedded modules are designed to meet network operator requirements for receiver performance, they are still susceptible to various performance inhibitors.

As part of the Engineering Services package, Sierra Wireless offers modem OTA sensitivity testing and desensitization (desense) investigation. For more information, contact your account manager or the Sales Desk (see Contact Information on page 3).

Note: Sierra Wireless has the capability to measure TIS (Total Isotropic Sensitivity) and TRP (Total Radiated Power) according to CTIA's published test procedure.

Sensitivity vs. Frequency

For UMTS bands, sensitivity is defined as the input power level in dBm that produces a BER (Bit Error Rate) of 0.1%. Sensitivity should be measured at all UMTS frequencies across each band.

For LTE bands, sensitivity is defined as the RF level at which throughput is 95% of maximum.

Supported Frequencies

The EM7565 supports:
- Multiple-band LTE—See Table 4-1 on page 42 (supported bands) and Table 4-2 on page 42 (LTE bandwidth support).
- LTE Advanced carrier aggregation—See Table 1-1 on page 12, Table 1-2 on page 13 and Table 1-3 on page 14 for details.
- Multiple-band WCDMA/HSPA/HSPA+/DC-HSPA+—See Table 4-3 on page 43.
- Multiple-band WCDMA receive diversity
- GPS, GLONASS, BeiDou, Galileo, QZSS—See Table 4-7 on page 47.
- Inter-RAT and inter-frequency cell reselection and handover between supported frequency bands

Table 4-1: LTE Frequency Bands

Band	Frequency (Tx)	Frequency (Rx)
B1	1920–1980 MHz	2110–2170 MHz
B2	1850–1910 MHz	1930–1990 MHz
B3	1710–1785	1805–1880 MHz
B4	1710–1755	2110–2155 MHz
B5	824–849 MHz	869–894 MHz
B7	2500–2570 MHz	2620–2690 MHz
B8	880–915 MHz	925–960 MHz
B9	1749.9–1784.9 MHz	1844.9–1879.9 MHz
B12	699–716 MHz	729–746 MHz
B13	777–787 MHz	746–756 MHz
B18	815–830 MHz	860–875 MHz
B19	830–845 MHz	875–890 MHz
B20	832–862 MHz	791–821 MHz
B26	814–849 MHz	859–894 MHz
B28	703–748 MHz	758–803 MHz
B29	n/a	717–728 MHz
B30	2305–2315 MHz *Note: B30 Tx is disabled.*	2350–2360 MHz
B32	n/a	1452–1496 MHz
B41	2496–2690 MHz (TDD)	
B42[a]	3400–3600 MHz (TDD)	
B43[a]	3600–3800 MHz (TDD)	
B46	n/a	5150–5925 MHz (TDD)
B48[a]	3550–3700 MHz (TDD)	
B66	1710–1780 MHz	2110–2200 MHz

a. B42/B43/B48 disabled as of publication date, support pending regulatory approval

Table 4-2: LTE Bandwidth Support[a]

Band	1.4 MHz	3 MHz	5 MHz	10 MHz	15 MHz	20 MHz
B1	✘	✘	✔	✔	✔	✔
B2	✔	✔	✔	✔	✔[b]	✔[b]

Table 4-2: LTE Bandwidth Support[a] (Continued)

Band	1.4 MHz	3 MHz	5 MHz	10 MHz	15 MHz	20 MHz
B3	✔	✔	✔	✔	✔[b]	✔[b]
B4	✔	✔	✔	✔	✔	✔
B5	✔	✔	✔	✔[b]	✘	✘
B7	✘	✘	✔	✔	✔[c]	✔[b,c]
B8	✔	✔	✔	✔[b]	✘	✘
B9	✘	✘	✔	✔	✔[b]	✔[b]
B12	✔	✔	✔[b]	✔[b]	✘	✘
B13	✘	✘	✔[b]	✔[b]	✘	✘
B18	✘	✘	✔	✔[b]	✔[b]	✘
B19	✘	✘	✔	✔[b]	✔[b]	✘
B20	✘	✘	✔	✔[b]	✔[b]	✔[b]
B26	✔	✔	✔	✔[b]	✔[b]	✘
B28	✘	✔	✔	✔[b]	✔[b]	✔[b,c]
B30	✘	✘	✔	✔[b]	✘	✘
B32	✘	✘	✔	✔	✔	✔
B41	✘	✘	✔	✔	✔	✔
B42[d]	✘	✘	✔	✔	✔	✔
B43[d]	✘	✘	✔	✔	✔	✔
B46	✘	✘	✘	✔	✘	✔
B48[d]	✘	✘	✔	✔	✔	✔
B66	✘	✘	✔	✔	✔	✔

a. Table contents are derived from 3GPP TS 36.521-1 v12.6.0, table 5.4.2.1-1.
b. Bandwidth for which a relaxation of the specified UE receiver sensitivity requirement (Clause 7.3 of 3GPP TS 36.521-1 v12.6.0) is allowed.
c. Bandwidth for which uplink transmission bandwidth can be restricted by the network for some channel assignments in FDD/TDD co-existence scenarios in order to meet unwanted emissions requirements (Clause 6.6.3.2 of 3GPP TS 36.521-1 v12.6.0).
d. B42/B43/B48 disabled as of publication date, support pending regulatory approval

Table 4-3: WCDMA Frequency Bands Support

Band	Frequency (Tx)	Frequency (Rx)
Band 1	1920–1980 MHz	2110–2170 MHz
Band 2	1850–1910 MHz	1930–1990 MHz
Band 4	1710–1755 MHz	2110–2155 MHz
Band 5	824–849 MHz	869–894 MHz

Table 4-3: WCDMA Frequency Bands Support (Continued)

Band	Frequency (Tx)	Frequency (Rx)
Band 6	830–840 MHz	875–885 MHz
Band 8	880–915 MHz	925–960 MHz
Band 9	1749.9–1784.9 MHz	1844.9–1879.9 MHz
Band 19	830–845 MHz	875–890 MHz

Conducted Rx Sensitivity / Tx Power

Note: Values in the following tables are preliminary, pending transceiver matching/testing.

Table 4-4: Conducted Rx (Receive) Sensitivity — LTE Bands

LTE bands		Conducted Rx sensitivity (dBm)			
		Primary (Typ)	Secondary (Typ)	SIMO (Typ)	SIMO[a] (Worst case)
B1	Full RB on downlink; BW: 10 MHz[b]	-97.5	-97.5	-100.0	-96.3
B2		-98.0	-97.5	-100.5	-94.3
B3		-97.0	-98.0	-100.5	-93.3
B4		-97.0	-98.0	-100.0	-96.3
B5		-99.0	-100.5	-102.5	-94.3
B7		-97.0	-99.0	-101.0	-94.3
B8		-98.5	-100.5	-102.5	-93.3
B9		-97.0	-98.5	-100.5	-95.3
B12		-98.0	-101.0	-102.5	-93.3
B13		-98.0	-101.0	-103.0	-93.3
B18		-99.0	-101.0	-103.0	-96.3
B19		-98.5	-100.5	-102.5	-96.3
B20		-98.5	-101.0	-103.5	-93.3
B26		-99.0	-100.5	-102.5	-93.8
B28		-98.5	-100.5	-102.5	-94.8
B29		-97.0	-101.0	-102.5	-93.3
B30		-97.0	-99.0	-101.0	-95.3
B32		-99.5	-98.0	-101.5	-96.3
B41		-96.5	-98.0	-100.5	-94.3
B42[c]		-97.0	-98.5	-101.0	-95.0
B43[c]		-97.0	-97.5	-101.0	-95.0
B48[c]		-97.0	-98.0	-101.0	-95.3
B66		-97.0	-98.0	-100.0	-95.8
B46	Full RB on downlink; BW: 20 MHz	-96.5	-97.0	-99.0	-88.5

a. Per 3GPP specification
b. Sensitivity values scale with bandwidth:
x_MHz_Sensitivity = 10_MHz_Sensitivity - 10*log(10 MHz/x_MHz)
Note: Bandwidth support is dependent on firmware version.
c. B42/B43/B48 disabled as of publication date, support pending regulatory approval

Table 4-5: Conducted Rx (Receive) Sensitivity — UMTS Bands

UMTS bands		Conducted Rx sensitivity (dBm)		
		Primary (Typical)	Secondary (Typical)	Primary/Secondary (Worst case)[a]
Band 1	0.1% BER 12.2 kbps	-110.6	-110.5	-106.7
Band 2		-111.2	-110.4	-104.7
Band 4		-110.1	-110.6	-106.7
Band 5		-111.4	-113.5	-104.7
Band 6		-111.2	-113.5	-106.7
Band 8		-111.4	-113.4	-103.7
Band 9		-110.1	-111.3	-105.7
Band 19		-111.1	-113.4	-106.7

a. Per 3GPP specification

Table 4-6: Conducted Tx (Transmit) Power Tolerances

Bands	Conducted Tx power	Notes
LTE		
LTE bands 1,2,3,4,5,8,9,12,13,18,19,20,26,28,66	+23 dBm ± 1 dB	
LTE bands 7,41,42[a],43[a], 48[a]	+22 dBm ± 1 dB	
UMTS		
Band 1 (IMT 2100 12.2 kbps) Band 2 (UMTS 1900 12.2 kbps) Band 4 (AWS 1700/2100 12.2 kbps) Band 5 (UMTS 850 12.2 kbps) Band 6 (UMTS 800 12.2 kbps) Band 8 (UMTS 900 12.2 kbps) Band 9 (UMTS 1700 12.2 kbps) Band 19 (UMTS 800 12.2 kbps)	+23 dBm ± 1 dB	Connectorized (Class 3)

a. B42/B43/B48 disabled as of publication date, support pending regulatory approval

GNSS Specifications

Note: For detailed electrical performance criteria, see Recommended GNSS Antenna Specifications on page 71.

.
Table 4-7: GNSS Specifications

Parameter/feature	Description
Satellite channels	Maximum 30 channels (16 GPS, 14 GLONASS), simultaneous tracking
Protocols	NMEA 0183 V3.0
Acquisition time[a]	Hot start: 1 s Warm start: 29 s Cold start: 32 s
Accuracy	Horizontal: < 2 m (50%); < 5 m (90%) Altitude: < 4 m (50%); < 8 m (90%) Velocity: < 0.2 m/s
Sensitivity	Tracking[b]: -160 dBm Acquisition[c] (Assisted): -158 dBm Acquisition (Standalone): -145 dBm
Operational limits	Altitude <6000 m or velocity <100 m/s (Either limit may be exceeded, but not both.)

a. Acquisition times measured with signal strength = -135 dBm
b. Tracking sensitivity is the lowest GNSS signal level for which the device can still detect an in-view satellite 50% of the time when in sequential tracking mode.
c. Acquisition sensitivity is the lowest GNSS signal level for which the device can still detect an in-view satellite 50% of the time.

The module includes an internal GNSS LNA, as shown in Figure 3-3 on page 22.

›› 5: Power

Power Consumption

Power consumption measurements in the tables below are for the EM7565 connected to the host PC via USB.

The module does not have its own power source and depends on the host device for power. For a description of input voltage requirements, see Power Supply on page 28.

Table 5-1: Averaged Standby DC Power Consumption[a]

Signal	Description	Bands[b]	Current			Notes / configuration
			Typ	Max[c]	Unit	
VCC	**Standby current consumption (Sleep mode activated[d])**					
	LTE	LTE bands	2.8	3.3	mA	DRX cycle = 8 (2.56 s)
	HSPA / WCDMA	UMTS bands	2.8	3.3	mA	DRX cycle = 8 (2.56 s)
	Standby current consumption[e] (Sleep mode deactivated[d])					
	LTE	LTE bands	37	42	mA	DRX cycle = 8 (2.56 s)
	HSPA / WCDMA	UMTS bands	37	42	mA	DRX cycle = 8 (2.56 s)
	Low Power Mode (LPM)/Offline Mode[e] (Sleep mode activated[d])					
	RF disabled, but module is operational		2.1	2.6	mA	
	Low Power Mode (LPM)/Offline Mode[e] (Sleep mode deactivated[d])					
	RF disabled, but module is operational		37	40	mA	
	Leakage current					
	Module powered off— Full_Card_Power_Off# is Low, and VCC is supplied		70	120	µA	

a. Preliminary, subject to change.
b. For supported bands, see Table 4-1, LTE Frequency Bands, on page 42 and Table 4-3, WCDMA Frequency Bands Support, on page 43.
c. Measured at 25ºC/nominal 3.3 V voltage.
d. Assumes USB bus is fully suspended during measurements
e. LPM and standby power consumption will increase when LEDs are enabled. To reduce power consumption, configure LEDs to remain off while in standby and LPM modes.

Table 5-2: Averaged Call Mode DC Power Consumption

Description	Tx power	Current[a]		Notes
		Typ	Unit	
LTE	0 dBm	510	mA	3 CA, 20 MHz+20 MHz+20 MHz BW
		420	mA	3 CA, 10 MHz+10 MHz+10 MHz BW
		382	mA	2 CA, 20 MHz+20 MHz BW
		310	mA	2 CA, 10 MHz+10 MHz BW
		300	mA	Single Carrier, 20 MHz BW
		250	mA	Single Carrier, 10 MHz BW
	20 dBm	820	mA	3 CA, 20 MHz+20 MHz+20 MHz BW
		710	mA	3 CA, 10 MHz+10 MHz+10 MHz BW
		690	mA	2 CA, 20 MHz+20 MHz BW
		590	mA	2 CA, 10 MHz+10 MHz BW
		610	mA	Single Carrier, 20 MHz BW
		530	mA	Single Carrier, 10 MHz BW
	23 dBm	1030	mA	3 CA, 20 MHz+20 MHz+20 MHz BW
		900	mA	3 CA, 10 MHz+10 MHz+10 MHz BW
		880	mA	2 CA, 20 MHz+20 MHz BW
		750	mA	2 CA, 10 MHz+10 MHz BW
		780	mA	Single Carrier, 20 MHz BW
		690	mA	Single Carrier, 10 MHz BW
DC-HSPA/HSPA	0 dBm	220	mA	All speeds
	20 dBm	460	mA	All speeds
	23 dBm	540	mA	Worst case
Peak current (averaged over 100 µs)		1.3	A	All LTE/WCDMA bands

a. Measured at 25ºC/nominal 3.3 V voltage

Product Technical Specification

Table 5-3: Miscellaneous DC Power Consumption

Signal	Description	Min	Typ	Max	Unit	Notes/configuration
		Current/Voltage				
		Min	Typ	Max		
VCC	USB active current	—	15	20	mA	High speed USB connection, C_L = 50 pF on D+ and D- signals
	Inrush current	—	2.2	2.5	A	• Assumes power supply turn on time > 100µs • Dependent on host power supply rise time.
	Maximum current	—	—	1.5	A	• Across all bands, all temperature ranges • 3.3 V supply
GNSS Signal connector	Active bias on GNSS port	—	—	100	mA	Voltage applied to the GNSS antenna to power electronics inside the antenna (GNSS RF connector in Figure 4-1 on page 37).
		3.05	3.15	3.25	V	

Warning: *The maximum RF power level allowable on any RF port is +10dBm—damage may occur if this level is exceeded.*

Module Power States

The module has five power states, as described in Table 5-4.

Table 5-4: Module Power States

State	Details	Host is powered	USB interface active	RF enabled

Normal (Default state)	• Module is active
	• Default state. Occurs when VCC is first applied, Full_Card_Power_Off# is deasserted (pulled high), and W_DISABLE# is deasserted
	• Module is capable of placing/receiving calls, or establishing data connections on the wireless network
	• Current consumption is affected by several factors, including:
	  • Radio band being used
	  • Transmit power
	  • Receive gain settings
	  • Data rate
		✔	✔	✔

Table 5-4: Module Power States (Continued)

State	Details	Host is powered	USB interface active	RF enabled

Low power ('Airplane mode')	• Module is active
	• Module enters this state:
	  • Under host interface control:
	    · Host issues AT+CFUN=0 (*[1] AT Command Set for User Equipment (UE) (Release 6) (Doc# 3GPP TS 27.007)*)), or
	    · Host asserts W_DISABLE#, after AT!PCOFFEN=0 has been issued.
	  • Automatically, when critical temperature or voltage trigger limits have been reached))
		✔	✔	✘

Sleep	• Normal state of module between calls or data connections • Module cycles between wake (polling the network) and sleep, at network provider-determined interval.	✔	✘	✘
Off	• Host keeps module powered off by asserting Full_Card_Power_Off# (signal pulled low or left floating) • Module draws minimal current • See Full_Card_Power_Off# and RESET# on page 35 for more information.	✔	✘	✘
Disconnected	• Host power source is disconnected from the module and all voltages associated with the module are at 0 V.	✘	✘	✘

Power State Transitions

The module uses state machines to monitor supply voltage and operating temperature, and notifies the host when critical threshold limits are exceeded. (See Table 5-5 for trigger details and Figure 5-1 for state machine behavior.)

Power state transitions may occur:
• Automatically, when critical supply voltage or module temperature trigger levels are encountered.
• Under host control, using available AT commands in response to user choices (for example, opting to switch to airplane mode) or operating conditions.

Table 5-5: Power State Transition Trigger Levels

Transition	Voltage		Temperature[a]		Notes
	Trigger	V	Trigger	°C	
Normal to Low Power	VOLT_HI_CRIT	4.4	TEMP_LO_CRIT	-45	• RF activity suspended
	VOLT_LO_CRIT	3.135	TEMP_HI_CRIT	105	

Table 5-5: Power State Transition Trigger Levels (Continued)

Transition	Voltage		Temperature[a]		Notes
	Trigger	V	Trigger	°C	
Low Power to Normal	VOLT_HI_NORM	4.3	TEMP_NORM_LO	-30	
Low Power to Normal *or* Remain in Normal (Remove warnings)	VOLT_LO_NORM	3.3	TEMP_HI_NORM	70	• RF activity resumed
Normal (Issue warning)	VOLT_LO_WARN	3.2	TEMP_HI_WARN	85	• In the TEMP_HI_WARN state, the module may have reduced performance (Class B temperature range).
Power off/on (Host-initiated)	-	-	-	-	• Power off recommended when supply voltage or module operating temperature is critically low or high.

a. Module-reported temperatures at the printed circuit board.
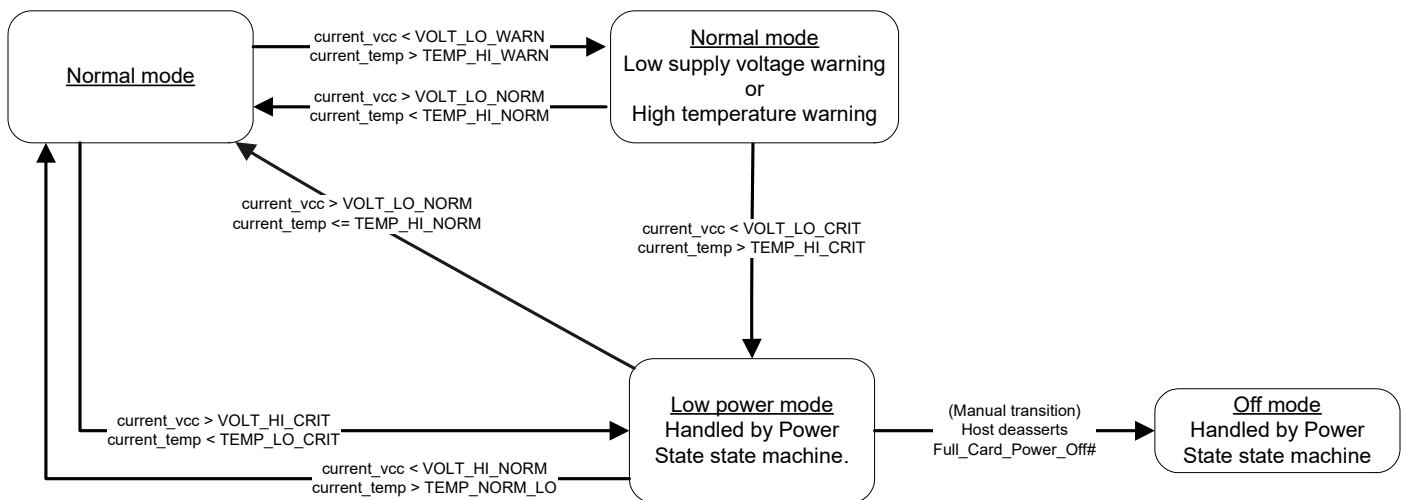
Figure 5-1: Voltage/Temperature Monitoring State Machines

Power Interface

Power Ramp-up

On initial power up, inrush current depends on the power supply rise time—turn on time >100 µs is required for < 3A inrush current.

The supply voltage must remain within specified tolerances while this is occurring.

Timing

Power On/Off Timing for the USB

Figure 5-2 describes the timing sequence for powering the module on and off.

Note: Before reaching the "Active" state, signals on the host port are considered to be undefined and signal transitions may occur. This undefined state also applies when the module is in reset mode, during a firmware update, or during the Power-off sequence. The host must consider these undefined signal activities when designing the module interface.

Note: The host should not drive any signals to the module until >100 ms from the start of the power-on sequence.
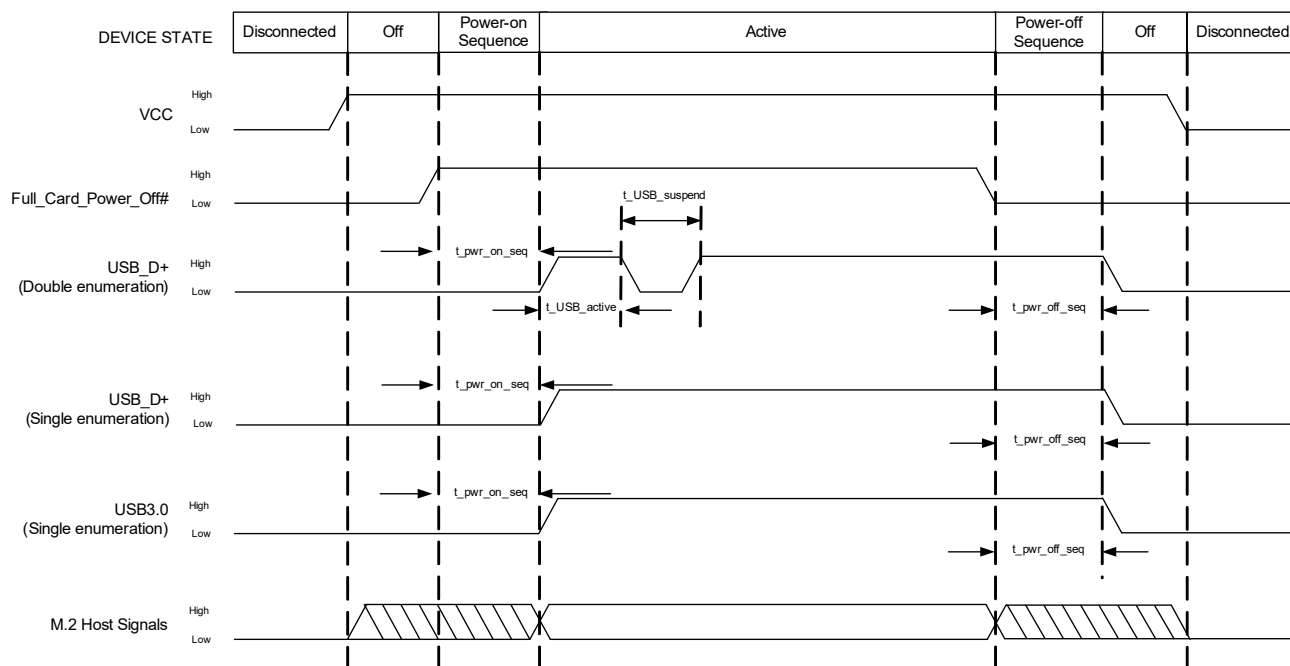
Figure 5-2: Signal Timing (Full_Card_Power_Off#, and USB Enumeration)

Table 5-6: USB 2.0 Power-On/Off Timing Parameters (Double Enumeration)

Parameter	Typical (s)	Maximum (s)
t_pwr_on_seq	0.8	0.9
t_USB_active	0.12	0.2
t_USB_suspend	8.5	11
t_pwr_off_seq	21.4	25

Table 5-7: USB 2.0 Power-On/Off Timing Parameters (Single Enumeration)

Parameter	Typical (s)	Maximum (s)
t_pwr_on_seq	8.7	11
t_pwr_off_seq	21.4	25

Table 5-8: USB 3.0 Power-On/Off Timing Parameters (Single Enumeration)

Parameter	Typical (s)	Maximum (s)
t_pwr_on_seq	8.6	11
t_pwr_off_seq	21.5	25

USB Enumeration

The unit supports single and double USB enumeration with the host:
- Single enumeration:
  - Enumeration starts within maximum t_pwr_on_seq seconds of power-on.
- Double enumeration—As shown in Figure 5-2:
  - First enumeration starts within t_pwr_on_seq seconds of power-on (while USB_D+ is high)
  - Second enumeration starts after t_USB_suspend (when USB_D+ goes high again)

Reset Timing

To reset the module, hold the RESET# signal low for at least 3 seconds.

Required Shutdown Sequence

Warning: *To avoid causing issues with the file system, follow this shutdown sequence.*

1. Drive Full_Card_Power_Off# low.
2. Wait for at least t_pwr_off_seq seconds.
3. Remove power.

Power Supply Noise

Noise in the power supply can lead to noise in the RF signal.

The power supply ripple limit for the module is no more than 100 mVp-p 1 Hz to 100 kHz. This limit includes voltage ripple due to transmitter burst activity.

Additional decoupling capacitors can be added to the main VCC line to filter noise into the device.

SED (Smart Error Detection)

The module uses a form of SED to track premature modem resets.
- Module tracks consecutive resets occuring soon after power-on.
- After a sixth consecutive reset, the module waits in boot-and-hold mode for a firmware download to resolve the power-cycle problem.

Tx Power Control

The module's Tx power limit may be controlled using either SAR backoff AT commands, defined in *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)*, or the DPR (Dynamic power control) signal. Use the GPIOSARENABLE parameter for !CUSTOM to choose the method:
- AT commands:
  - !SARSTATEDFLT—Set (or report) the default SAR backoff state that the device uses when it powers up. This setting is persistent across power cycles and overrides any PRI setting.
  - !SARSTATE—Set (or report) the current SAR backoff state (override the default state). This change in state is non-persistent across power cycles.
  - !SARBACKOFF—Set (or report) the maximum Tx power limit for a specific band/technology/state combination.

Note: A customization is available to invert the DPR logic. (e.g. make DPR low = No SAR backoff)

- Dynamic power control—The module's firmware monitors DPR (pin 25) and adjusts the RF Tx power appropriately, as detailed in Table 5-9. (This state change is equivalent to issuing the !SARSTATE AT command.)

Table 5-9: Dynamic Power Control of SAR Backoff State

DPR	SAR backoff state
High[a]	No SAR backof
Low	Backoff 1

a. DPR is pulled high by default.

Note: The host can implement an open collector drive for the DPR pin (if a 1.8 V-compatible drive is not available).

>> |6: Software Interface

Support Tools

The EM7565 is compatible with the following support tools from Sierra Wireless and authorized third parties:
- Firmware update utilities from Sierra Wireless
- Sierra Wireless Logger
- QXDM from QUALCOMM
- QUALCOMM Product Support Tool (QPST)
- Windows and Linux SDKs (including API and drivers)

Host Interface

The device supports the following protocols for modem communication:
- MBIM (Mobile Broadband Interface Model)
- Qualcomm QMI interface. (Please contact your Sierra Wireless account representative for QMI interface documentation.)

7: Mechanical and Environmental Specifications

The EM7565 module complies with the mechanical and environmental specifications in Table 7-1. Final product conformance to these specifications depends on the OEM device implementation.

Table 7-1: Mechanical and Environmental Specifications

	Mode	Details
Ambient temperature	Operational Class A	-30ºC to +70ºC – 3GPP compliant
	Operational Class B	-40ºC to +85ºC, with appropriate heatsinking – non-3GPP compliant (reduced operating parameters required)
	Non-operational	-40ºC to +85ºC, 96 hours (from MIL-STD 202 Method 108)
Relative humidity	Non-operational	85ºC, 85% relative humidity for 48 hours (non-condensing)
Vibration	Non-operational	Random vibration, 10 to 2000 Hz, 0.1 g^2/Hz to 0.0005 g^2/Hz, in each of three mutually perpendicular axes. Test duration of 60 minutes for each axis, for a total test time of three hours.
Shock	Non-operational	Half sine shock, 11 ms, 30 g, 8x each axis Half sine shock, 6 ms, 100 g, 3x each axis
Drop	Non-operational	1 m on concrete on each of six faces, two times (module only)
(Electrostatic discharge (See Electrostatic Discharge (ESD) on page 59.)	Operational	The RF port (antenna launch and RF connector) complies with the IEC 61000-4-2 standard: • Electrostatic Discharge Immunity: Test: Level3 Air Discharge: ±8 kV
	Non-operational	The host connector interface complies with the following standard only: • minimum ±500 V Human Body Model (JESD22-A114-B)
Thermal considerations		See Thermal Considerations on page 60.
Form factor		M.2 Form Factor
Dimensions		Length: 42±0.15 mm (max) Width: 30±0.15 mm (max) Thickness: Above PCB—1.50 mm (max) PCB—0.88 mm (max) Weight: 6.5 g

Device Views

Figure 7-1: Top View

Ø 10.0
vacuum cup

Lid assembly
orientation arrow

Shield lid

(Note: All dimensions shown in mm.)
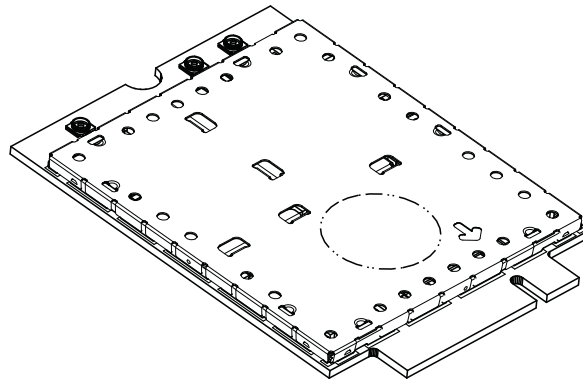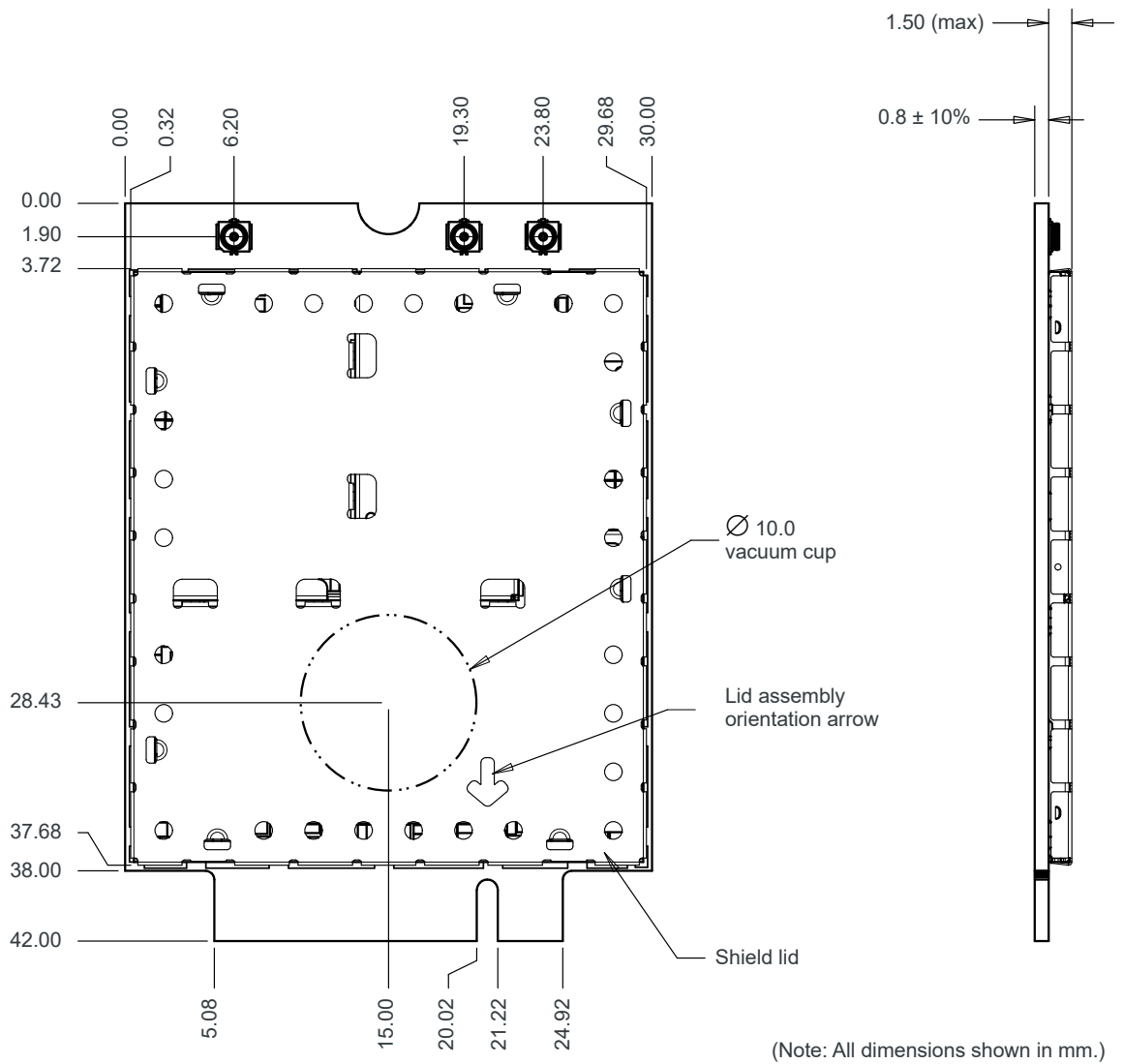
Figure 7-2: Dimensioned View

Product Marking (Labeling)

Figure 7-3: Unit Product Marking Example—Laser-etched, Typical Representation (Not to scale. Contents will vary by SKU.)

The EM7565 product marking is laser-etched and may contain:
- Sierra Wireless logo and product name
- IMEI number in Data Matrix barcode format
- SKU number (when required)
- Factory Serial Number (FSN) in alphanumeric format
- Manufacturing date code (incorporated into FSN)
- Licensed vendor logo
- Certification marks/details

Note: The EM7565 supports OEM partner-specific label requirements.

Electrostatic Discharge (ESD)

The OEM is responsible for ensuring that the EM7565 host interface pins are not exposed to ESD during handling or normal operation. (See Table 7-1 on page 57 for specifications.)

ESD protection is highly recommended for the SIM connector at the point where the contacts are exposed, and for any other signals from the host interface that would be subjected to ESD by the user of the product. (The device includes ESD protection on the antenna.)

Thermal Considerations

Embedded modules can generate significant amounts of heat that must be dissipated in the host device for safety and performance reasons.
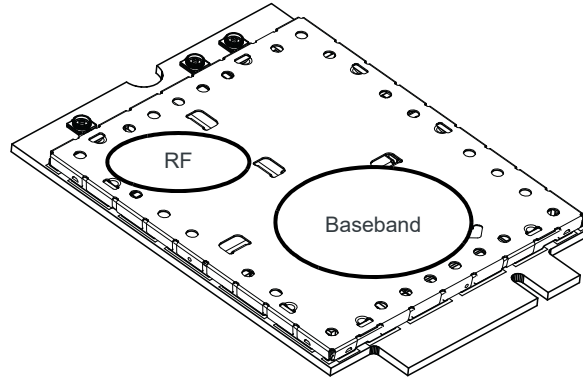
Figure 7-4: Shield Locations (Top View)

The amount of thermal dissipation required depends on:
- Supply voltage—Maximum power dissipation for the module can be up to 3.5 W at voltage supply limits.
- Usage—Typical power dissipation values depend on the location within the host, amount of data transferred, etc.

Specific areas requiring heat dissipation are shown in Figure 7-5:
- RF—Bottom face of module near RF connectors. Likely to be the hottest area.
- Baseband—Bottom face of module, below the baseband area.
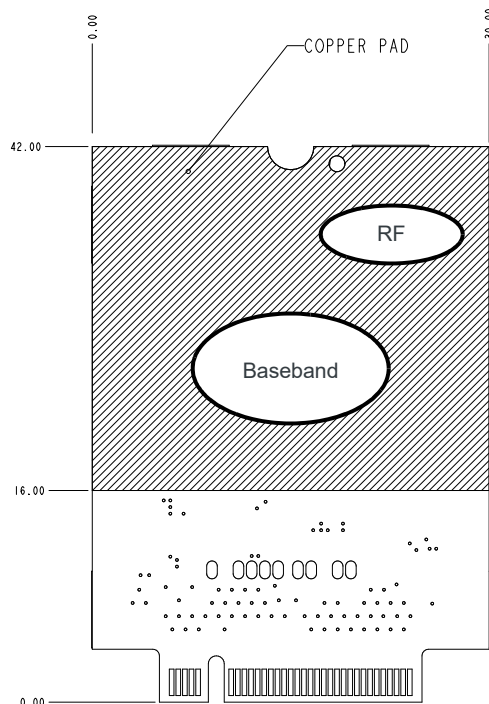
Figure 7-5: Copper Pad Location on Bottom Side of Module

To enhance heat dissipation:
- It is recommended to add a heat sink that mounts the module to the main PCB or metal chassis (a thermal compound or pads must be used between the module and the heat sink).
- Maximize airflow over/around the module.
- Locate the module away from other hot components.
- Module mounting holes must be used to attach (ground) the device to the main PCB ground or a metal chassis.
- You may also need active cooling to pull heat away from the module.

Note: Adequate dissipation of heat is necessary to ensure that the module functions properly.

Module Integration Testing

When testing your integration design:
- Test to your worst case operating environment conditions (temperature and voltage)
- Test using worst case operation (transmitter on 100% duty cycle, maximum power)
- Monitor temperature at all shield locations. Attach thermocouples to the areas indicated in Figure 7-4 on page 60 (RF, Baseband).

Note: Make sure that your system design provides sufficient cooling for the module.

(For acceptance, certification, quality, and production (including RF) test suggestions, see Testing on page 75.)

8: Regulatory Compliance and Industry Certifications

This module is designed to meet, and upon commercial release, will meet the requirements of the following regulatory bodies and regulations, where applicable:
- Federal Communications Commission (FCC) of the United States
- The Certification and Engineering Bureau of Industry Canada (IC)
- The National Communications Commission (NCC) of Taiwan, Republic of China
- Ministry of Internal Affairs and Communications (MIC) of Japan
- Radio Equipment Directive (RED) of the European Union

Upon commercial release, the following industry certifications will have been obtained, where applicable:
- GCF
- PTCRB

Additional certifications and details on specific country approvals may be obtained upon customer request—contact your Sierra Wireless account representative for details.

Additional testing and certification may be required for the end product with an embedded EM7565 module and are the responsibility of the OEM. Sierra Wireless offers professional services-based assistance to OEMs with the testing and certification process, if required.

Important Notice

Because of the nature of wireless communications, transmission and reception of data can never be guaranteed. Data may be delayed, corrupted (i.e., have errors) or be totally lost. Although significant delays or losses of data are rare when wireless devices such as the Sierra Wireless module are used in a normal manner with a well-constructed network, the Sierra Wireless module should not be used in situations where failure to transmit or receive data could result in damage of any kind to the user or any other party, including but not limited to personal injury, death, or loss of property. Sierra Wireless and its affiliates accept no responsibility for damages of any kind resulting from delays or errors in data transmitted or received using the Sierra Wireless module, or for failure of the Sierra Wireless module to transmit or receive such data.

Safety and Hazards

Do not operate your EM7565 module:
- In areas where blasting is in progress
- Where explosive atmospheres may be present including refuelling points, fuel depots, and chemical plants
- Near medical equipment, life support equipment, or any equipment which may be susceptible to any form of radio interference. In such areas, the EM7565 module **MUST BE POWERED OFF**. Otherwise, the EM7565 module can transmit signals that could interfere with this equipment.

In an aircraft, the EM7565 module **MUST BE POWERED OFF**. Otherwise, the EM7565 module can transmit signals that could interfere with various onboard systems and may be dangerous to the operation of the aircraft or disrupt the cellular network. Use of a cellular phone in an aircraft is illegal in some jurisdictions. Failure to observe this instruction may lead to suspension or denial of cellular telephone services to the offender, or legal action or both.

Some airlines may permit the use of cellular phones while the aircraft is on the ground and the door is open. The EM7565 module may be used normally at this time.

Important Compliance Information for the United States and Canada

The EM7565 module, upon commercial release, will have been granted modular approval for mobile applications. Integrators may use the EM7565 module in their final products without additional FCC/IC (Industry Canada) certification if they meet the following conditions. Otherwise, additional FCC/IC approvals must be obtained.

1. At least 20 cm separation distance between the antenna and the user's body must be maintained at all times.

2. To comply with FCC/IC regulations limiting both maximum RF output power and human exposure to RF radiation, the maximum antenna gain including cable loss in a mobile-only exposure condition must not exceed the limits stipulated in Table 8-1 on page 64.

3. The EM7565 module may transmit simultaneously with other collocated radio transmitters within a host device, provided the following conditions are met:
    - Each collocated radio transmitter has been certified by FCC/IC for mobile application.
    - At least 20 cm separation distance between the antennas of the collocated transmitters and the user's body must be maintained at all times.
    - The radiated power of a collocated transmitter must not exceed the EIRP limit stipulated in Table 8-1 on page 64.

Table 8-1: Antenna Gain and Collocated Radio Transmitter Specifications

	Operating mode	Tx Freq Range (MHz)		Max Time-Avg Cond Power (dBm)	Antenna Gain Limit (dBi)		EIRP Limits (dBm)
					Standalone	Collocated	
EM7565 Embedded Module	WCDMA Band 2/ LTE B2	1850	1910	24	6	4	30
	WCDMA Band 4/ LTE B4	1710	1755	24	6	4	30
	WCDMA Band 5/ LTE B5	824	849	24	6	4	30
	LTE B7	2500	2570	23.8	9	4	32.8
	LTE B12	699	716	24	6	4	30
	LTE B13	777	787	24	6	4	30
	LTE B26	814	849	24	6	4	30
	LTE B41	2496	2690	23.8	9	4	32.8
	LTE B66	1710	1780	24	6	4	30
Collocated transmitters	WLAN 2.4 GHz	2400	2500				30
	WLAN 5 GHz	5150	5850				30
	BT	2400	2500				16
	WiGig	58320	62640				25

4. A label must be affixed to the outside of the end product into which the EM7565 module is incorporated, with a statement similar to the following:

   · **This device contains FCC ID: N7NEM75**
   Contains transmitter module IC: 2417C-EM75 where 2417C-EM75 is the module's certification number.

5. A user manual with the end product must clearly indicate the operating requirements and conditions that must be observed to ensure compliance with current FCC/IC RF exposure guidelines.

The end product with an embedded EM7565 module may also need to pass the FCC Part 15 unintentional emission testing requirements and be properly authorized per FCC Part 15.

Note: If this module is intended for use in a portable device, you are responsible for separate approval to satisfy the SAR requirements of FCC Part 2.1093 and IC RSS-102.

A: Audio Support

The EM7565 host I/O connector provides pins to support PCM or I2S audio interfaces as listed in Table A-1.

Table A-1: Host interface (67-pin) Connections — Module View[a]

Pin	Signal name	Pin type[b]	Description	Direction to module	Active state	Voltage levels (V) Min	Typ	Max
20	PCM_CLK / I2S_CLK[c]	-	(PCM_CLK) PCM Clock	Input	High	1.17	1.80	2.10
					Low	-0.30		0.63
				Output	High	1.35	1.80	1.90
					Low	0		0.45
			(I2S_CLK) I^{2}S Clock	Output	High	1.35		1.90
					Low	0		0.45
22	PCM_DIN / I2S DIN	-	PCM Data In/ I^{2}S Data In	Input	High	1.17	1.80	2.10
					Low	-0.30		0.63
24	PCM_DOUT / I2S DOUT	-	PCM Data Out/ I^{2}S Data Out	Output	High	1.35	1.80	1.90
					Low	0		0.45
28	PCM_SYNC / I2S_WS[c]	-	(PCM_SYNC) PCM Sync	Input	High	1.17	1.80	2.10
					Low	-0.30		0.63
				Output	High	1.35	1.80	1.90
					Low	0		0.45
			(I2S_WS) I^{2}S Word Select	Output	High	1.35		1.90
					Low	0		0.45
56	I2C_DATA[d]	-	I^{2}C serial bus data (for external codec)	Input	High	1.17	1.80	2.10
					Low	-0.30		0.63
				Output	High	1.35	1.80	1.90
					Low	0		0.45
58	I2C_CLK[d]	-	I^{2}C serial bus clock (for external codec)	Input	High	1.17	1.80	2.10
					Low	-0.30		0.63
				Output	High	1.35	1.80	1.90
					Low	0		0.45

a. The host should leave all 'NC' ('no connect) pins unconnected.
b. I—Input; O—Digital output; OC—Open Collector output; PU—Digital input (internal pull up); PD—Digital input (internal pull down); V—Power or ground
c. Functions as input when in PCM slave mode. Otherwise, functions as output in either PCM or I2S master mode.
d. Keep this pin NC when not used (I^{2}C function is not needed).

PCM/I2S Audio Interface

The module implements a PCM/I²S digital audio interface using a dedicated serial link for digital audio data; all other signals, such as subcoding and control, are transmitted separately. Default setting is PCM slave mode, but this can be switched, using AT commands, to PCM master mode, I²S master mode, or I²S slave mode.

PCM/I²S signals are summarized in the following table.

Table A-2: PCM/I2S Interface Signals

Signal name	Pin	Description
PCM_CLK/I2S_CLK	20	PCM Clock/I2S Clock
PCM_DIN/I2S_DIN	22	PCM Data In/I2S Data In
PCM_DOUT/I2S_DOUT	24	PCM Data Out/I2S Data Out
PCM_SYNC/I2S_WS	28	PCM Sync/I2S Word Select

PCM

The PCM interface supports the following features:
- Either master mode or slave mode
- Auxiliary PCM
- 8k and 16k sampling rates
- Linear, μ-law and A-law formats
- Padding setting (enable or disable)
- 8, 16, 32, 64, 128, and 256 bits per frame
- Bit frequency (sample rate * bits per frame)

The following figures and table illustrate PCM signals timing.
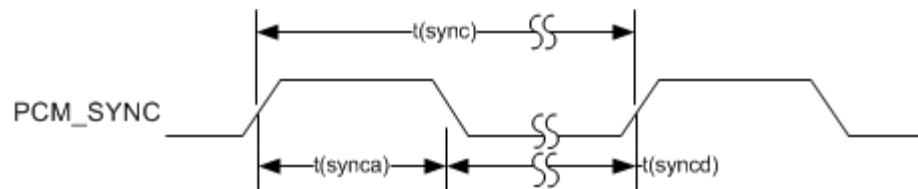
Figure A-1: PCM_SYNC Timing
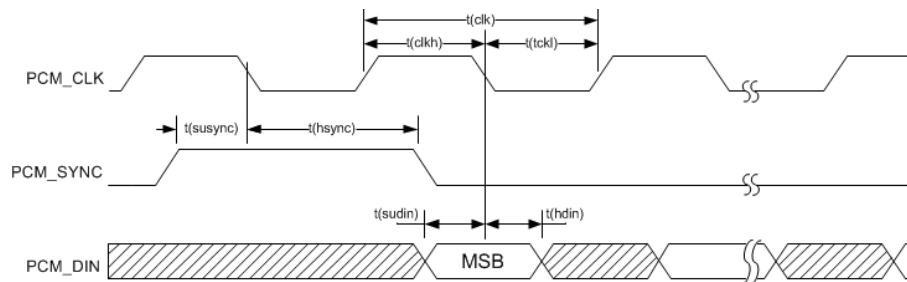
Figure A-2: PCM Codec to Module Timing
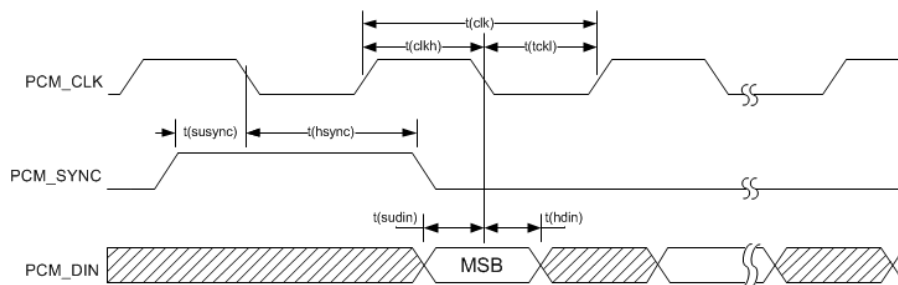
Figure A-3: Module to PCM Codec Timing

Table A-3: PCM Timing[a]

Parameter	Description	Min	Typ	Max	Units
T(sync)	PCM_FS cycle time	-	125	-	us
T(synch)	PCM_FS high time	-	488	-	ns
T(cyncl)	PCM_FS low time	-	124.5	-	us
T(clk)	PCM_CLK cycle time	-	488	-	ns
T(clkh)	PCM_CLK high time	-	244	-	ns
T(clkl)	PCM_CLK low time	-	244	-	ns
T(sync_offset)	PCM_SYNC offset time to PCM_CLK falling	-	122	-	ns
T(sudin)	PCM_DIN setup time before falling edge of PCM_CLK	60	-	-	ns
T(hdin)	PCM_DIN hold time after falling edge of PCM_CLK	60	-	-	ns
T(pdout)	Delay from PCM_CLK rising to PCM_DOUT valid	-	-	60	ns
T(zdout)	Delay from PCM_CLK falling to PCM_DOUT HIGH-Z	-	-	60	ns

a.   Maximum PCM clock rate is 2.048 MHz.

I²S

The I²S interface can be used to transfer serial digital audio to or from an external stereo DAC/ADC and supports the following features:

- Master mode only (follows Philips I²S bus specifications for timing)
- 48K sampling rate
- 16 bits per channel
- 1536 kHz bit clock
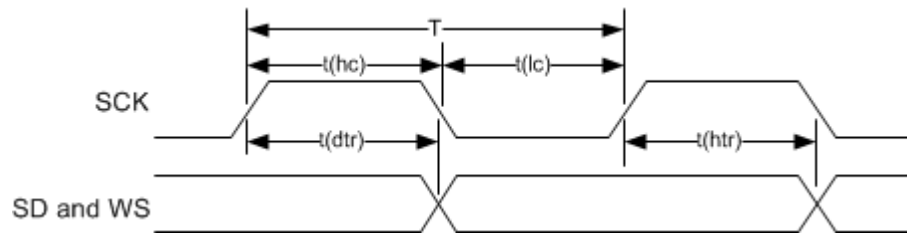
Figure A-4: I2S Transmitter Timing Diagram

Table A-4: Master Transmitter with Data Rate = 3.072 MHz (±10%)[a]

Parameter	Description	Condition	Min	Typ	Max	Units
T	Clock period	I2S requirement: min T=293	293	326	359	ns
t(hc)	Clock high	I2S requirement: min > 0.35T	120	-	-	ns
t(lc)	Clock low	I2S requirement: min > 0.35T	120	-	-	ns
t(dtr)	Delay	I2S requirement: max < 0.8T	-	-	250	ns
t(htr)	Hold time	I2S requirement: min > 0	100	-	-	ns

a. maximum sample rate = 48 KHz at 3.072 MHz (32 bits per sample)

>> B: Antenna Specification

This appendix describes recommended electrical performance criteria for main path, diversity path, and GNSS antennas used with AirPrime embedded modules.

The performance specifications described in this section are valid while antennas are mounted in the host device with antenna feed cables routed in their final application configuration.

*Note: Antennas should be designed **before** the industrial design is finished to make sure that the best antennas can be developed*

Recommended Main/Diversity Antenna Specifications

Table B-1: Antenna Requirements [a]

Parameter	Requirements	Comments
Antenna system	(LTE) External multi-band 2x2 MIMO antenna system (Ant1/Ant2)[b] (3G) External multi-band antenna system with diversity (Ant1/Ant2)[c]	If Ant2 includes GNSS, then it must also satisfy requirements in Table B-2 on page 71.
Operating bands— Antenna 1	All supporting Tx and Rx frequency bands.	
Operating bands— Antenna 2	All supporting Rx frequency bands, plus GNSS frequency bands if Antenna 2 is used in shared Diversity/MIMO/GNSS mode.	
VSWR of Ant1 and Ant2	• < 2:1 (recommended) • < 3:1 (worst case)	On all bands including band edges
Total radiated efficiency of Ant1 and Ant2	> 50% on all bands	• Measured at the RF connector. • Includes mismatch losses, losses in the matching circuit, and antenna losses, excluding cable loss. • Sierra Wireless recommends using antenna efficiency as the primary parameter for evaluating the antenna system. Peak gain is not a good indication of antenna performance when integrated with a host device (the antenna does not provide omni-directional gain patterns). Peak gain can be affected by antenna size, location, design type, etc.—the antenna gain patterns remain fixed unless one or more of these parameters change.

Table B-1: Antenna Requirements (Continued)[a]

Parameter	Requirements	Comments
Radiation patterns of Ant1 and Ant2	Nominally Omni-directional radiation pattern in azimuth plane.	
Envelope correlation coefficient between Ant1 and Ant2	• < 0.5 on Rx bands below 960 MHz • < 0.2 on Rx bands above 1.4 GHz	
Mean Effective Gain of Ant1 and Ant2 (MEG1, MEG2)	≥ -3 dBi	
Ant1 and Ant2 Mean Effective Gain Imbalance I MEG1 / MEG2 I	< 2 dB for MIMO operation < 6 dB for diversity operation	
Maximum antenna gain	Must not exceed antenna gains due to RF exposure and ERP/ EIRP limits, as listed in the module's FCC grant.	See Important Compliance Information for the United States and Canada on page 63.
Isolation between Ant1 and Ant2 (S21)	> 10 dB	• If antennas can be moved, test all positions for both antennas. • Make sure all other wireless devices (Bluetooth or WLAN antennas, etc.) are turned OFF to avoid interference.
Power handling	• > 1 W	• Measure power endurance over 4 hours (estimated talk time) using a 1 W CW signal—set the CW test signal frequency to the middle of each supporting Tx band. • Visually inspect device to ensure there is no damage to the antenna structure and matching components. • VSWR/TIS/TRP measurements taken before and after this test must show similar results.

a. These worst-case VSWR figures for the transmitter bands may not guarantee RSE levels to be within regulatory limits. The device alone meets all regulatory emissions limits when tested into a cabled (conducted) 50 ohm system. With antenna designs with up to 2.5:1 VSWR or worse, the radiated emissions could exceed limits. The antenna system may need to be tuned in order to meet the RSE limits as the complex match between the module and antenna can cause unwanted levels of emissions. Tuning may include antenna pattern changes, phase/delay adjustment, passive component matching. Examples of the application test limits would be included in FCC Part 22, Part 24 and Part 27,test case 4.2.2 for WCDMA (ETSI EN 301 908-1), where applicable.
b. Ant1—Primary, Ant2—Secondary (Diversity/MIMO/GNSS)
c. Ant1—Primary, Ant2—Secondary (Diversity/GNSS)

Recommended GNSS Antenna Specifications

Table B-2: GNSS Antenna Requirements

Parameter	Requirements	Comments
Frequency range	• Wide-band GNSS: 1559–1606 MHz recommended • Narrow-band GPS: 1575.42 MHz ±2 MHz minimum • Narrow-band Galileo: 1575.42 MHz ±2 MHz minimum • Narrow-band BeiDou: 1561.098 MHz ±2 MHz minimum • Narrow-band GLONASS: 1601.72 MHz ±4.2 MHz minimum • Narrow-band QZSS 1575.42 MHz ±2 MHz minimum	
Field of view (FOV)	• Omni-directional in azimuth • -45° to +90° in elevation	
Polarization (average Gv/Gh)	> 0 dB	Vertical linear polarization is sufficient.
Free space average gain (Gv+Gh) over FOV	> -6 dBi (preferably > -3 dBi)	Gv and Gh are measured and averaged over -45° to +90° in elevation, and ±180° in azimuth.
Gain	• Maximum gain and uniform coverage in the high elevation angle and zenith. • Gain in azimuth plane is not desired.	
Average 3D gain	> -5 dBi	
Isolation between GNSS and Ant1	> 10 dB in all uplink bands	
Typical VSWR	< 2.5:1	
Polarization	Any other than LHCP (left-hand circular polarized) is acceptable.	

Antenna Tests

The following guidelines apply to the requirements described in Table B-1 on page 69 and Table B-2 on page 71:
- Perform electrical measurements at room temperature (+20°C to +26°C) unless otherwise specified
- For main and diversity path antennas, make sure the antennas (including contact device, coaxial cable, connectors, and matching circuit with no more than six

components, if required) have nominal impedances of 50 Ω across supported frequency bands.
- All tests (except isolation/correlation coefficient)—Test the main or diversity antenna with the other antenna terminated.
- Any metallic part of the antenna system that is exposed to the outside environment needs to meet the electrostatic discharge tests per IEC61000-4-2 (conducted discharge +8kV).
- The functional requirements of the antenna system are tested and verified while the embedded module's antenna is integrated in the host device.

Note: Additional testing, including active performance tests, mechanical, and accelerated life tests can be discussed with Sierra Wireless' engineering services. Contact your Sierra Wireless representative for assistance.

C: Design Checklist

This chapter provides a summary of the design considerations mentioned throughout this guide. This includes items relating to the power interface, RF integration, thermal considerations, cabling issues, and so on.

Note: This is NOT an exhaustive list of design considerations. It is expected that you will employ good design practices and engineering principles in your integration.

Table C-1: Hardware Integration Design Considerations

Suggestion	Section where discussed
Component placement	
If an ESD suppressor is not used on the host device, allow space on the SIM connector for series resistors in layout. (Up to 100 Ω may be used depending on ESD testing requirements).	SIM Implementation on page 32
Minimize RF cable losses as these affect performance values listed in product specification documents.	RF Connections on page 37
Antennas	
Match the module/antenna coax connections to 50 Ω—mismatched antenna impedance and cable loss negatively affect RF performance.	RF Connections on page 37
If installing UMTS and CDMA modules in the same device, consider using separate antennas for maximum performance.	Antenna and Cabling on page 38
Power	
Make sure the power supply can handle the maximum current specified for the module type.	Power Consumption on page 48
Limit the total impedance of VCC and GND connections to the SIM at the connector to less than 1 Ω (including any trace impedance and lumped element components—inductors, filters, etc.). All other lines must have a trace impedance less than 2 Ω.	SIM Implementation on page 32
Decouple the VCC line close to the SIM socket. The longer the trace length (impedance) from socket to module, the greater the capacitance requirement to meet compliance tests.	SIM Implementation on page 32
PCB signal routing	
USB 2.0/3.0—Route these signals over 90 Ω differential lines on the PCB.	
I2C port—If supported, route these signals away from noise-sensitive signals on the PCB.	
PCM port—If supported, route these signals away from noise-sensitive signals on the PCB.	
EMI/ESD	
Investigate sources of localized interference early in the design cycle.	Methods to Mitigate Decreased Rx Performance on page 40

Table C-1: Hardware Integration Design Considerations (Continued)

Suggestion	Section where discussed
Provide ESD protection for the SIM connector at the exposed contact point (in particular, the CLK, VCC, IO, and RESET# lines).	SIM Implementation on page 32
Keep very low capacitance traces on the UIM_DATA and UIM_CLK signals.	SIM Implementation on page 32
To minimize noise leakage, establish a very good ground connection between the module and host.	Ground Connection on page 39
Route cables away from noise sources (for example, power supplies, LCD assemblies, etc.).	Methods to Mitigate Decreased Rx Performance on page 40
Shield high RF-emitting components of the host device (for example, main processor, parallel bus, etc.).	Methods to Mitigate Decreased Rx Performance on page 40
Use discrete filtering on low frequency lines to filter out unwanted high-order harmonic energy.	Methods to Mitigate Decreased Rx Performance on page 40
Use multi-layer PCBs to form shielding layers around high-speed clock traces.	Methods to Mitigate Decreased Rx Performance on page 40
Thermal	
Test to worst case operating conditions—temperature, voltage, and operation mode (transmitter on 100% duty cycle, maximum power).	Thermal Considerations on page 60
Use appropriate techniques to reduce module temperatures (for example, airflow, heat sinks, heat-relief tape, module placement, etc.).	Thermal Considerations on page 60
Host/Modem communication	
Make sure the host USB driver supports remote wakeup, resume, and suspend operations, and serial port emulation.	*[4] AirCard/AirPrime USB Driver Developer's Guide (Doc# 2130634)*
When no valid data is being sent, do not send SOF tokens from the host (causes unnecessary power consumption).	*[4] AirCard/AirPrime USB Driver Developer's Guide (Doc# 2130634)*

>> D: Testing

Note: All AirPrime embedded modules are factory-tested to ensure they conform to published product specifications.

Developers of OEM devices integrating Sierra Wireless AirPrime embedded modules should include a series of test phases in their manufacturing process to make sure that *their* devices work properly with the embedded modules.

Suggested phases include:
- Acceptance Testing—Testing of modules when they are received from Sierra Wireless
- Certification Testing—Testing of completed devices to obtain required certifications before beginning mass production
- Production Testing—Testing of completed devices with the modules embedded
- Quality Assurance Testing—Post-production

AT Command Entry Timing Requirement

Some AT commands require time to process before additional commands are entered. For example, the modem will return "OK" when it receives **AT!DAFTMACT**. However, if **AT!DARCONFIG** is received too soon after this, the modem will return an error.

When building automated test scripts, ensure that sufficient delays are embedded where necessary to avoid these errors.

Acceptance Testing

---

*Note: Acceptance testing is typically performed for **each** shipment received.*

When you receive a shipment from Sierra Wireless, you should make sure it is suitable before beginning production.

From a random sampling of units, test that:
- Units are operational
- Units are loaded with the correct firmware version

Acceptance Test Requirements

To perform the suggested tests, you require a test system in which to temporarily install the module, and you must be able to observe the test device's LED indicator.

Acceptance Test Procedure

The following is a suggested acceptance testing procedure using Sierra Wireless' Skylight™ software:

Test 1: Check Power-up and Initialization

1. After installing the module, start the test system.
2. Launch Skylight.
3. Check the LED—If the LED is off, there is a problem with the module or with the connection to the LED.

Test 2: Check Version Numbers

1. From Skylight, select **Help > About**.
2. Verify that the firmware version in the **About** window is correct.
3. Close the **About** window.

If the module fails either of these tests, or is not recognized by Skylight:

1. Replace the module with one that is known to work correctly and repeat the tests.
2. If the tests are successful, reinstall the original module and repeat the tests.

If the module still does not work correctly, contact your account manager.

Certification Testing

Note: Typically, certification testing of your device with the integrated module is required one time only.

The AirPrime embedded module has been certified as described in Regulatory Compliance and Industry Certifications on page 62.

When you produce a host device with a Sierra Wireless AirPrime embedded module, you must obtain certifications for the final product from appropriate regulatory bodies in the jurisdictions where it will be distributed.

The following are *some* of the regulatory bodies from which you may require certification—it is your responsibility to make sure that you obtain all necessary certifications for your product from these or other groups:

*   FCC (Federal Communications Commission—www.fcc.gov)
*   Industry Canada (www.ic.gc.ca)
*   GCF (Global Certification Forum—www.globalcertificationforum.org) outside of North America
*   PTCRB (PCS Type Certification Review Board—www.ptcrb.com) in North America

Production Testing

Note: Production testing typically continues for the life of the product.

Production testing ensures that, for each assembled device, the module is installed correctly (I/O signals are passed between the host and module), and the antenna is connected and performing to specifications (RF tests).

Typical items to test include:
- Host connectivity
- Baseband (host/module connectors)
- RF assembly (Tx and/or Rx, as appropriate)
- Network availability
- Host/device configuration issues

*Note: The number and types of tests to perform are **your** decision—the tests listed in this section are guidelines only. Make sure that the tests you perform exercise functionality to the degree that **your** situation requires.*

Use an appropriate test station for your testing environment (see Acceptance Test Requirements on page 75 for suggestions) and use AT commands to control the integrated module.

Note: Your test location must be protected from ESD to avoid interference with the module and antenna(s), assuming that your test computer is in a disassembled state.
Also, consider using an RF shielding box—local government regulations may prohibit unauthorized transmissions.

Functional Production Test

This section presents a suggested procedure for performing a basic manual functional test on a laboratory bench using an EM7565 Embedded Module and a hardware development kit. When you have become familiar with the testing method, use it to develop your own automated production testing procedures.

Suggested Production Tests

Consider the following tests when you design your production test procedures for devices with the AirPrime module installed.
- Visual check of the module's connectors and RF assemblies
- Module is operational
- USB connection is functional
- LED is functional
- Power on/off
- Firmware revision check
- Rx tests on main and auxiliary paths
- Tx test

Production Test Procedure

The following is a suggested test plan—you must decide which tests are appropriate for your product. You may wish to add additional tests that more fully exercise the capabilities of your product.

Using an appropriate Dev Kit-based test station, and referring to the appropriate AT command references:

1. Visually inspect the module's connectors and RF assemblies for obvious defects before installing it in the test station.
2. Ensure that the module is turned off before beginning your tests—Drive Full_-Card_Power_Off# low or leave floating.
3. Test Full_Card_Power_Off#—Turn on the module by driving Full_Card_Power_Off# high.
4. Test USB functionality—Check for USB enumeration.
   - (Windows systems) The Device Manager shows the device under Network adapters. For example:
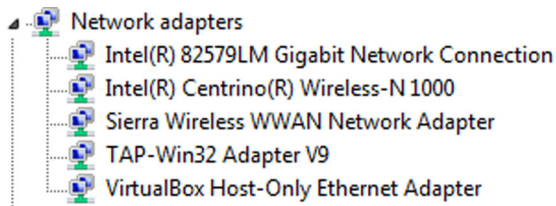
5. Make sure your modem is connected and running, and then establish contact with the module:
   - Windows systems: Use a terminal emulation/communications program such as Microsoft HyperTerminal® to connect to the Sierra Wireless modem (see listings in Step 4):
   a. Start HyperTerminal.
   b. Select **File > Connection Description**. The Connection Description dialog box appears.
      i. Type Sierra in the Name box and click **OK**. The Connect To dialog box appears.
      ii. Click **OK** without changing any of the displayed information. The Connect dialog box appears.
      iii. Click **Cancel**.
      iv. Type ATZ in the HyperTerminal window. If the connection is established, the message OK appears.

Note: If necessary, use **AT E1** *to enable echo.*

6. Display the firmware version:
   - **AT+GMR**
7. Test the LED—Set the LED in blinking mode using this command, then visually verify that the LED turns off and on:
   - **AT!LDTEST=0,0** (LED on)
   - **AT!LDTEST=0,1** (LED off)

8. Unlock the extended AT command set. (Note: Use AT!ENTERCND? to check command syntax, which is SKU-dependent.):
   - **AT!ENTERCND="<password>"**

9. Put the module in diagnostic/factory test mode:
   - **AT!DAFTMACT**

10. Communicate with the SIM using **+CPIN** or **+CIMI**.
    When performing RF tests, use a test platform as described in Suggested Testing Equipment on page 88.

11. Test RF transmission, if desired:
    - (UMTS) See UMTS (WCDMA) RF Transmission Path Test on page 79.
    - (LTE) See LTE RF Transmission Path Test on page 81.

12. Test RF reception, if desired:
    - (UMTS) See UMTS (WCDMA) RF Receive Path Test on page 83.
    - (LTE) See LTE RF Receive Path Test on page 85.

13. Test standalone GNSS functionality—See GNSS RF Receive Path Test on page 87.

14. Drive Full_Card_Power_Off# low (or leave floating) and confirm that the module powers down:
    - Windows systems—The Sierra Wireless items under the Ports (COM & LPT) entry in Device Manager disappear as the module powers off.

UMTS (WCDMA) RF Transmission Path Test

Note: This procedure segment is performed in Step 11 of the Production Test Procedure on page 78.

The suggested test procedure that follows uses the parameters in Table D-1.

Table D-1: Test Settings—UMTS Transmission Path

	Band	Frequency (MHz)	Band ID	Channel[a]
2100 MHz	Band 1	1950.0	9	9750
1900 MHz	Band 2	1880.0	15[b]	9400
1700 MHz	Band 4	1732.6	28	1413
850 MHz	Band 5	836.6	22	4183
800 MHz	Band 6	835.0	22	4175
900 MHz	Band 8	897.6	29	2788
1700 MHz	Band 9	1767.4	31	8837
800 MHz	Band 19	837.6	75	338

a. Channel value used by the !DARCONFIG command (!DARCONFIG uses uplink (Tx) channel at the center of the corresponding band (rounded down), for both Tx and Rx testing).
b. Either 15 (WCDMA1900A) or 16 (WCDMA1900B) may be used for testing.

Note: This procedure describes steps using the "Power Meter: Gigatronics 8651A" (with Option 12 and Power Sensor 80701A).

To test the DUT's transmitter path:
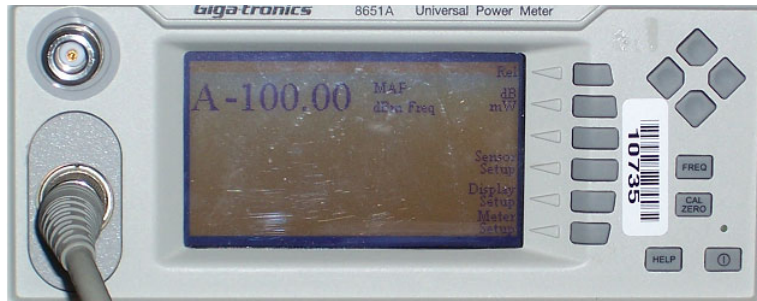
1. Set up the power meter:

   a. Make sure the meter has been given sufficient time to warm up, if necessary, to enable it to take accurate measurements.

   b. Zero-calibrate the meter.

   c. Enable MAP mode.

2. Prepare the DUT using the following AT commands:

   a. `AT!ENTERCND="<password>"` (Unlock extended AT command set.)

   b. `AT!DAFTMACT` (Enter test mode.)

   c. `AT!DARCONFIG=0,1,<bandValue>,<channel>`
      (e.g. AT!DARCONFIG=0,1,2,9400)
      (Set frequency band and channel. See Table D-1 for values.)

   d. `AT!DAWTXCONTROL=1,<power_dBm>`
      (e.g. AT!DAWTXCONTROL=1,10)
      (Enable Tx power output. <power_dBm> = -57.0 to 23.0)

   e. Take the measurement.

   f. Repeat steps c–e with different Tx power levels if needed.

   g. `AT!DAWTXCONTROL=0` (Disable Tx power output.)

   h. `AT!DARCONFIGDROP=1` (Drop the current UMTS configuration.)

3. Test limits—Run ten or more good DUTs through this test procedure to obtain a nominal output power value.
   - Apply a tolerance of ±5 to 6 dB to each measurement (assuming a good setup design).
   - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The module has a nominal output power of +23 dBm ±1 dB in WCDMA mode. However, the value measured by the power meter is significantly influenced (beyond the stated ±1 dB output power tolerance) by the test setup (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

Note: When doing the same test over the air in an RF chamber, values are likely to be significantly lower.

LTE RF Transmission Path Test

Note: This procedure segment is performed in Step 11 of the Production Test Procedure on page 78.

The suggested test procedure that follows uses the parameters in Table D-2..

Table D-2: Test Settings — LTE Transmission Path
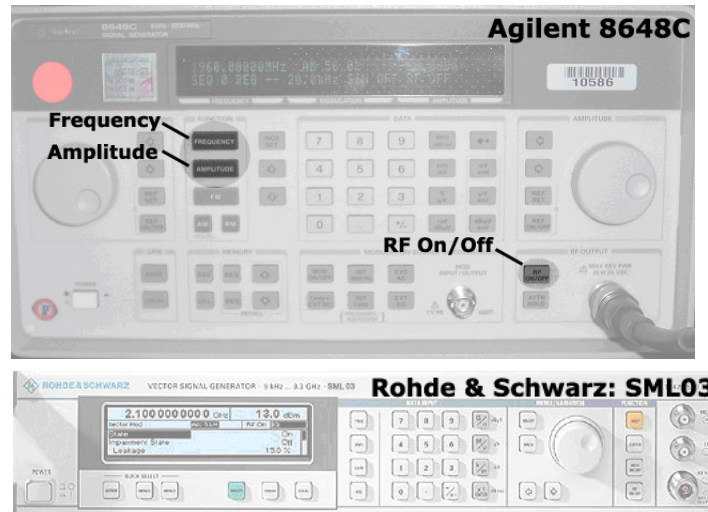
	Band #	Frequency (MHz)	Band ID	Channel[a]
2100 MHz	B1	1950.0	34	18300
1900 MHz	B2	1880.0	43	18900
1800 MHz	B3	1747.5	44	19575
1700 MHz	B4	1732.5	42	20175
850 MHz	B5	836.5	45	20525
2600 MHz	B7	2535.0	35	21100
900 MHz	B8	897.5	47	21625
1800 MHz	B9	1767.4	48	21975
700 MHz	B12	707.5	50	23095
700 MHz	B13	782.0	36	23230
850 MHz	B18	822.5	54	23925
850 MHz	B19	837.5	55	24075
800 MHz	B20	847.0	56	24300
850 MHz	B26	831.5	62	26865
700 MHz	B28	725.5	64	27435
2500 MHz	B41	2593.0	76	40620
3500 MHz	B42[b]	3500.0	77	42590
3700 MHz	B43[b]	3700.0	88	44590
3600 MHz	B48[b]	3625.0	96	55990
1700 MHz	B66	1745.0	83	132322

a. Channel value used by the !DARCONFIG command (!DARCONFIG uses uplink (Tx) channel at the center of the corresponding band (rounded down), for both Tx and Rx testing).
b. B42/B43/B48 disabled as of publication date, support pending regulatory approval

To test the DUT's transmitter path:

1. Set up the power meter:

    a. Make sure the meter has been given sufficient time to warm up, if necessary, to enable it to take accurate measurements.

    b. Zero-calibrate the meter.

    c. Enable MAP mode.

2. Prepare the DUT using the following AT commands:

    a. **AT!ENTERCND="<password>"** (Unlock extended AT command set.)

    b. **AT!DAFTMACT** (Enter test mode.)

    c. **AT!DARCONFIG=0,3,<bandValue>,<channel>,<lte_bw>**
        (e.g. AT!DARCONFIG=0,3,1,18300,3)

        (Set frequency band and channel. See Table D-1 for values. <lte_bw>: 0 (1.4 MHz), 1 (3 MHz), 2 (5 MHz), 3 (10 MHz), 4 (15 MHz), 5(20 MHz))

    d. **AT!DALTXCONTROL=0,1,<tx_pwr>,<waveform>,<mod>,<ns_val>,<num_RB>,<start_RB>**
        (e.g. AT!DALTXCONTROL=0,1,10,1,0,1,12,19)

        (Set LTE Tx power level, waveform, modulation and NS value. Programs PA range, LUT index, and digital gain to reach Tx power level with power limiting enabled.)

    e. Take the measurement.

    f. Repeat steps c–e with different Tx power levels if desired.

    g. **AT!DALTXCONTROL=0,0** (Disable Tx power control.)

    h. **AT!DARCONFIGDROP=3** (Drop the current LTE configuration.)

3. Test limits—Run ten or more good DUTs through this test procedure to obtain a nominal output power value.
    - Apply a tolerance of $\pm$5 to 6 dB to each measurement (assuming a good setup design).
    - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The module has a nominal output power of +23 dBm $\pm$1 dB in LTE mode. However, the value measured by the power meter is significantly influenced (beyond the stated $\pm$1 dB output power tolerance) by the test setup (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

Note: When doing the same test over the air in an RF chamber, values are likely to be significantly lower.

UMTS (WCDMA) RF Receive Path Test

Note: This procedure segment is performed in Step 12 of Production Test Procedure on page 78.

The suggested test procedure that follows uses the parameters in Table D-3.

Table D-3: Test Settings — UMTS Receive Path

	Band #	Frequency[a] (MHz)	Band ID	Channel[b]
2100 MHz	Band 1	2141.2	9	9750
1900 MHz	Band 2	1961.2	15[c]	9400
1700 MHz	Band 4	2133.7	28	1413
850 MHz	Band 5	882.7	22	4183
800 MHz	Band 6	881.2	22	4175
900 MHz	Band 8	943.7	29	2788
1700 MHz	Band 9	1863.6	31	8837
800 MHz	Band 19	883.7	75	338

a. Receive frequencies shown are 1.2 MHz offset from center
b. Channel value used by the !DARCONFIG command (!DARCONFIG uses uplink (Tx) channel at the center of the corresponding band (rounded down), for both Tx and Rx testing).
c. Either 15 (WCDMA1900A) or 16 (WCDMA1900B) may be used for testing.

To test the DUT's receive path:

1. Set up the signal generator:

    a. Set the amplitude to:
        *   -80 dBm
    b. Set the frequency for the band being tested. See Table D-3 on page 83 for frequency values.

2. Set up the DUT:

Warning: *The maximum RF power level allowable on any RF port is +10dBm—damage may occur if this level is exceeded.*

    a. AT!ENTERCND="<password>" (Unlock extended AT command set.)
    b. AT!DAFTMACT (Put modem into factory test mode.)
    c. AT!DARCONFIG=0,1,<bandValue>,<channel>
        (e.g. AT!DARCONFIG=0,1,2,9400)
                                        (Set frequency band and channel.
                                        See Table D-3 for values.)
    d. AT!DAGFTMRXAGC=0,1,0,0
                                        (Set LNA to maximum gain on primary Rx, and
                                        get the RSSI.)
    e. AT!DAGFTMRXAGC=0,1,0,1   (Set LNA to maximum gain on Diversity Rx, and
                                        get the RSSI.)
    f. AT!DARCONFIGDROP=1   (Drop the current UMTS configuration.)

3. Test limits—Run ten or more good DUTs through this test procedure to obtain a nominal received power value.
    *   Apply a tolerance of ± 5 to 6 dB to each measurement (assuming a good setup design).
    *   Make sure the measurement is made at a high enough level that it is not influenced by DUT-generated and ambient noise.
    *   The Signal Generator power level can be adjusted and new limits found if the radiated test needs greater signal strength.

- Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The value measured from the DUT is significantly influenced by the test setup and DUT design (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

LTE RF Receive Path Test

Note: This procedure segment is performed in Step 12 of the Production Test Procedure on page 78.

The suggested test procedure that follows uses the parameters in Table D-4.

Table D-4: Test Settings — LTE Receive Path

	Band #	Frequency[a] (MHz)	Band ID	Channel[b]
2100 MHz	B1	2142.0	34	18300
1900 MHz	B2	1962.0	43	18900
1800 MHz	B3	1844.5	44	19575
1700 MHz	B4	2134.5	42	20175
850 MHz	B5	883.5	45	20525
2600 MHz	B7	2657.0	35	21100
900 MHz	B8	944.5	47	21625
1800 MHz	B9	1864.4	48	21975
700 MHz	B12	739.5	50	23095
700 MHz	B13	753.0	36	23230
850 MHz	B18	869.5	54	23925
850 MHz	B19	884.5	55	24075
800 MHz	B20	808.0	56	24300
850 MHz	B26	878.5	62	26865
700 MHz	B28	782.5	64	27435
700 MHz	B29	See footnote[c].		
2300 MHz	B30	2357.0	66	27710
1500 MHz	B32	See footnote[c].		
2500 MHz	B41	2595.0	76	40620
3500 MHz	B42[d]	3502.0	77	42590

Table D-4: Test Settings — LTE Receive Path (Continued)

	Band #	Frequency[a] (MHz)	Band ID	Channel[b]
3700 MHz	B43[d]	3702.0	88	44590
5200 MHz	B46	See footnote[c].		
3600 MHz	B48[d]	3627.0	96	55990
1700 MHz	B66	2157.0	83	132322

a. Receive frequencies shown are 2 MHz offset from center
b. Channel value used by the !DARCONFIG command (!DARCONFIG uses uplink (Tx) channel at the center of the corresponding band (rounded down), for both Tx and Rx testing).
c. Test procedure does not apply to this band. Downlink-only band requires CA mode testing in signaling mode (outside scope of this document; testing methodology to be determined by user).
d. B42/B43/B48 disabled as of publication date, support pending regulatory approval

To test the DUT's receive path (or diversity path, while connected to the diversity antenna):

Note: This procedure describes steps using the Agilent 8648C signal generator—the Rohde & Schwarz SML03 is shown for reference only.

1. Set up the signal generator:
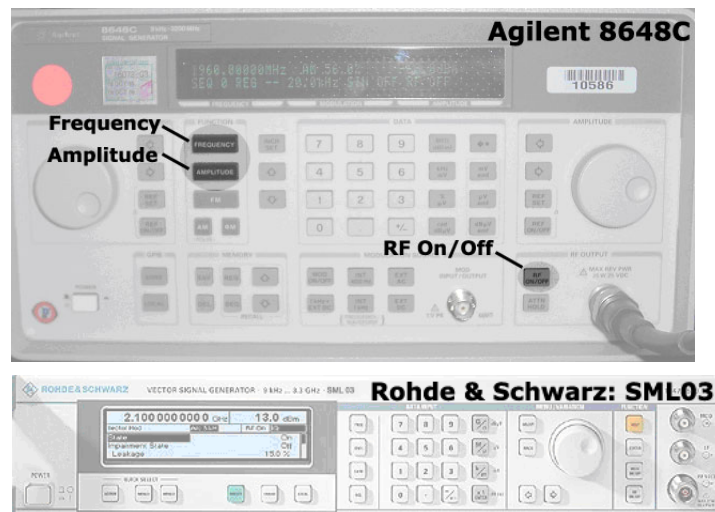
   a. Set the amplitude to -70 dBm

   b. Set the frequency for the band being tested. See Table D-4 for frequency values.

2. Set up the DUT:

Warning: *The maximum RF power level allowable on any RF port is +10dBm—damage may occur if this level is exceeded.*

   a. `AT!ENTERCND="<password>"`   (Unlock extended AT command set.)

   b. `AT!DAFTMACT` (Put modem into factory test mode.)

   c. `AT!DARCONFIG=0,3,<bandValue>,<channel>,<lte_bw>`
      (e.g. AT!DARCONFIG=0,3,1,18300,3)
      (Set frequency band and channel. See Table D-4

for values. \<lte_bw>: 0 (1.4 MHz), 1 (3 MHz), 2 (5 MHz), 3 (10 MHz), 4 (15 MHz), 5(20 MHz))

    d.   **AT!DAGFTMRXAGC=0,3,0,0**   (Set LNA to maximum gain on primary Rx, and get the RSSI.)

    e.   **AT!DAGFTMRXAGC=0,3,0,1**   (Set the LNA to maximum gain on Diversity Rx, and get the RSSI.)

    f.   **AT!DARCONFIGDROP=0,3**   (Drop the current LTE configuration.)

3. Test limits—Run ten or more good DUTs through this test procedure to obtain a nominal received power value.
   - Apply a tolerance of ±5 to 6 dB to each measurement (assuming a good setup design).
   - Make sure the measurement is made at a high enough level that it is not influenced by DUT-generated and ambient noise.
   - The Signal Generator power level can be adjusted and new limits found if the radiated test needs greater signal strength.
   - Monitor these limits during mass-production ramp-up to determine if further adjustments are needed.

Note: The value measured from the DUT is significantly influenced by the test setup and DUT design (host RF cabling loss, antenna efficiency and pattern, test antenna efficiency and pattern, and choice of shield box).

GNSS RF Receive Path Test

The GNSS receive path uses either the dedicated GNSS connector or the shared Diversity/MIMO/GNSS connector.

To test the GNSS receive path:

1. Inject a carrier signal at -110dBm, frequency 1575.52 MHz into the GNSS Rx path at the connector. (Note that this frequency is 100 kHz higher than the actual GPS L1 center frequency.)

2. Test the signal carrier-to-noise level at the GNSS receiver:

   a. **AT!ENTERCND="\<password>"** (Unlock extended AT command set.)

   b. **AT!DAFTMACT** (Put modem into factory test mode.)

   c. **AT!DACGPSTESTMODE=1** (Start CGPS diagnostic task.)

   d. **AT!DACGPSSTANDALONE=1** (Enter standalone RF mode.)

   e. **AT!DACGPSMASKON** (Enable log mask.)

   f. **AT!DACGPSCTON** (Return signal-to-noise and frequency measurements.)

   g. Repeat **AT!DACGPSCTON** five to ten times to ensure the measurements are repeatable and stable.

3. Leave the RF connection to the embedded module intact, and turn off the signal generator.

4. Take several more **!DACGPSCTON** readings. This will demonstrate a 'bad' signal in order to set limits for testing, if needed. This frequency offset should fall outside of the guidelines in the note below, which indicates that the CtoN result is invalid.

5. (Optional) Turn the signal generator on again, and reduce the level to -120dBm. Take more !DACGPSCTON readings and use these as a reference for what a marginal/poor signal would be.

Note: The response to AT!DACGPSCTON for a good connection should show CtoN within 58 +/- 5dB and Freq (frequency offset) within 100000 Hz +/- 5000 Hz .

Quality Assurance Testing

The quality assurance tests that you perform on your finished products should be designed to verify the performance and quality of your devices.

The following are *some* testing suggestions that can confirm that the antenna is interfaced properly, and that the RF module is calibrated and performs to specifications:
- Module registration on cellular networks
- Power consumption
- Originate and terminate data and voice (if applicable) calls
- Cell hand-off
- Transmitter and receiver tests
- FER (Frame Error Rate) as an indicator of receiver sensitivity/performance
- Channel and average power measurements to verify that the device is transmitting within product specifications
- RF sensitivity tests
- RF sensitivity testing—BER/BLER for different bands and modes
- Transmitter and receiver tests (based on relevant sections of the 3GPP TS51010 and 3GPP 34121 documents)

Suggested Testing Equipment

To perform production and post-production tests, you will require appropriate testing equipment. A test computer can be used to coordinate testing between the integrated module (on the development kit or host) and the measurement equipment, usually with GPIB connections. The suggested setup includes a power meter to test RF output power and a signal generator to evaluate the receiver.

Testing Assistance Provided by Sierra Wireless

Extended AT commands have been implemented to assist with performing FTA GCF tests and portions of CE Mark tests requiring radio module access. These are documented in the *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)*.

Sierra Wireless offers optional professional services based assistance to OEMs with regulatory approvals.

IOT/Operator Testing

Interoperability and Operator/Carrier testing of the finished system is the responsibility of the OEM. The test process will be determined with the chosen network operator(s) and will be dependent upon your business relationship with them, as well as the product's application and sales channel strategy.

Sierra Wireless offers assistance to OEMs with the testing process, if required.

Extended AT Commands for Testing

Sierra Wireless provides the *[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)*, which describes proprietary AT commands that may help in hardware integration design and testing (these commands are NOT intended for use by end users).

Some commands from this document that may be useful for hardware integration are listed in Table D-5 on page 89.

Table D-5: Extended AT Commands

Command	Description
Password commands	
!ENTERCND	Enable access to password-protected commands
!SETCND	Set AT command password
Modem reset and status commands	
!GSTATUS	Return the operation status of the modem (mode, band, channel, and so on)
!RESET	Reset the modem
Diagnostic commands	
!BAND	Select a set of frequency bands or reports current selection
Test commands	
!DAFTMACT	Put the modem into FTM (Factory Test Mode)
!DAFTMDEACT	Put the modem into online mode
!DAGFTMRXAGC	Get FTM Rx AGC (Primary or Diversity)
!DALGRXAGC	Return Rx AGC value (LTE)
!DALGTXAGC	Return Tx AGC value and transmitter parameters (LTE)
!DALTXCONTROL	Configure LTE Tx Parameters
!DAOFFLINE	Place modem offline
!DARCONFIG	Set Band and Channel
!DARCONFIGDROP	Drop Radio Configurations

Table D-5: Extended AT Commands

Command	Description
!DASLNAGAIN	Set the LNA (Low Noise Amplifier) gain state
!DAWGAVGAGC	Return averaged RX AGC value (WCDMA)
!DAWINFO	Return WCDMA mode RF information
!DAWTXCONTROL	Configure WCDMA Tx Power

≫ E: Thermal Testing

Worst Case Testing—Absolute vs Realistic

Sierra Wireless recommends that customers identify realistic worst-case conditions for their applications and perform appropriate thermal testing.

For example:

- If the device has very good throughput, it is likely near a tower so will not have to transmit at maximum Tx output power.
- If the device is transmitting at maximum Tx power, it is likely *not* near a tower and will not reach maximum throughput rates.
- Networks usually are sharing capacity among many users, so no single user is likely to reach maximum throughput rates for any significant length of time.
- If the device is transmitting at maximum throughput, it will likely do so for a limited time to limit the amount of data usage consumed from their data plan.

Suggested realistic worst-case test conditions

Sierra Wireless suggests using a worst-case test such as shown in Table E-1.

Table E-1: Suggested worst-case conditions

Condition	Value
Data throughput rate	150 Mbps/40 Mbps
Tx output power	20 dBm
Carrier aggregation	3CA
Test case	Scheduling—50% duty cycle, 2 ms period (i.e. On for 1 ms, Off for 1 ms)

Thermal Testing Process

To perform thermal testing of the module:

1. Mount the module in its designed location on the platform.
2. Provide the same amount of airflow as will be experienced in your application.
3. Set the platform's ambient to the higher limit of its ambient temperature specification and observe the board temperature ramp due to the ambient temperature. (Use **AT!PCTEMP?** or **SLQSNasSwiModemStatus**.)

Note: It is highly recommended to have a thermocouple measuring the air temperature around the module inside the platform, which will be close to the module's board temperature.

4. Set up a call with the use case for the platform (throughput rate, output power, duty cycle) on the worst-case band.

Note: The worst case band for power consumption and thermals is a 3CA call with PCC LTE Band 66 (20 MHz) and SCC any bands (20 MHz + 20 MHz). For example, Sierra Wireless tests using B66+B2+B66.

---

5. Observe the ramp in board temperature due to the call, and confirm whether the overall system performance still meets customer requirements.

6. Use AT!TMSTATUS? to check the module's thermal mitigation status (see [2] AirPrime EM75xx AT Command Reference (Doc# 41111748) for details).

7. Increase the platform's ambient temperature to determine the margin that exists over the desired temperature specifications as subsequent mitigation methods activate (e.g. UL data rate throttled, DL throughput throttled (third and second CA dropped), UL power reduced, Emergency Service).

>>|F: Packaging

Sierra Wireless AirPrime Embedded Modules are shipped in sealed boxes. The standard packaging (see Figure F-1), contains a single tray with a capacity of 100 modules. (Note that some SKUs may have custom packaging—contact Sierra Wireless for SKU-specific details.)

In the standard packaging, Embedded Modules are inserted, system connector first, into the bottom portion (T1) of a two-part tray. all facing the same direction. This allows the top edge of each Embedded Module to contact the top of the triangular features in the top portion (T2) of the tray (see Detail A).

The top and bottom portions of the tray snap together at the four connection points.
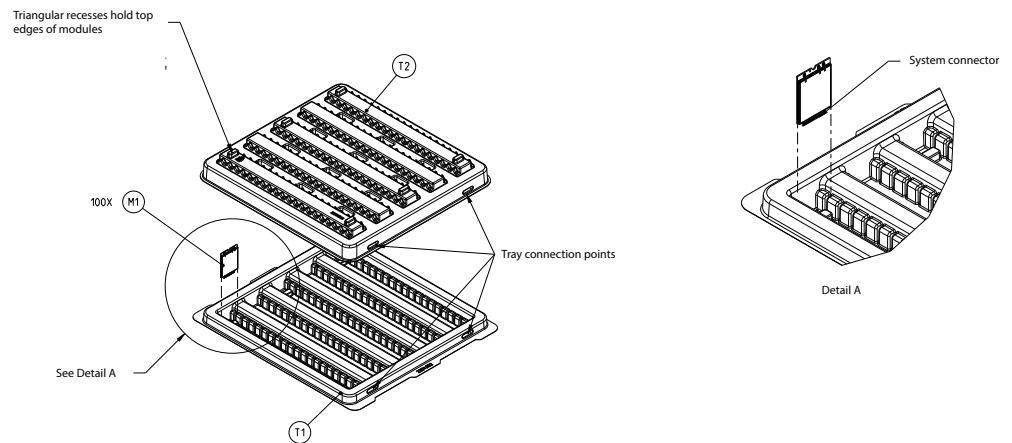
Figure F-1: Device Placement in Module Tray

The tray cover is secured to the tray base with ESD-safe tape (EP1) at the locations indicated. The tray is placed in a manufacturing box(B1), sealed with a security tape (P1), a manufacturing label (L3) is placed on the bottom-right corner, above the security tape, and if required a label (L4) is applied beside the manufacturing label. (See Figure F-2.)
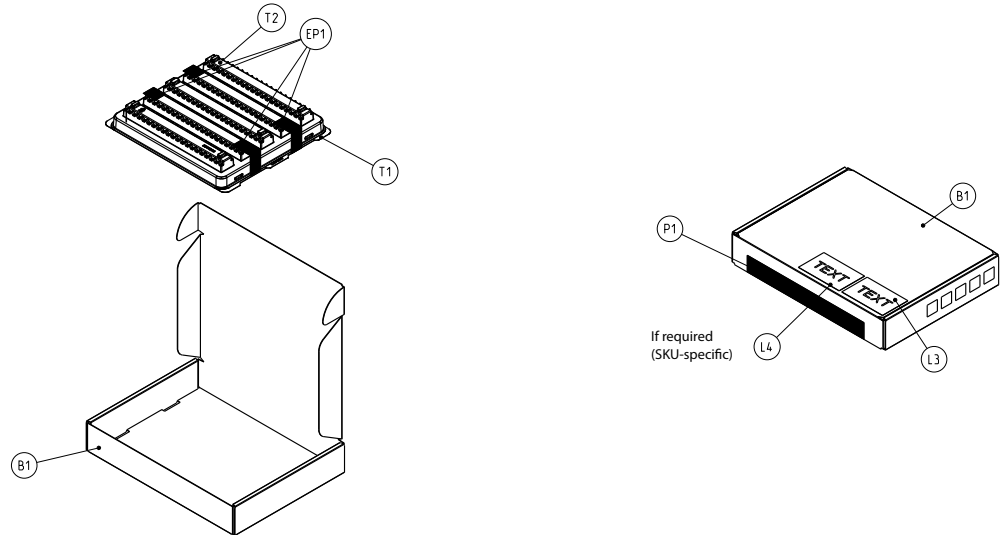
Figure F-2: Shipping Package

≫ G: References

This guide deals specifically with hardware integration issues that are unique to AirPrime embedded modules.

Sierra Wireless Documents

The Sierra Wireless documents listed below are available from www.sierrawireless.com. For additional documents describing embedded module design, usage, and integration issues, contact your Sierra Wireless account representative.

Command Documents

[1] AT Command Set for User Equipment (UE) (Release 6) (Doc# 3GPP TS 27.007)

[2] AirPrime EM75xx AT Command Reference (Doc# 41111748)

Other Sierra Documents

[3] M.2 Dev Kit Welcome Letter (Doc# 2400323)

[4] AirCard/AirPrime USB Driver Developer's Guide (Doc# 2130634)

Industry/Other Documents

The following non-Sierra Wireless references are not included in your documentation package:

[5] FCC Regulations - Part 15 - Radio Frequency Devices

[6] IEC-61000-4-2 level 3 (Electrostatic Discharge Immunity Test)

[7] Mobile Station (MS) Conformance Specification; Part 4: Subscriber Interface Module (Doc# 3GPP TS 11.10-4)

[8] PCI Express NGFF (M.2) Electromechanical Specification Revision 1.0

[9] Universal Serial Bus Specification, Rev 2.0

[10] Universal Serial Bus Specification, Rev 3.0

[11] JESD22-A114-B

[12] JESD22-C101

[13]MIPI Alliance Specification for RF Front-End Control Interface

H: Acronyms

Table H-1: Acronyms and Definitions

Acronym or term	Definition
3GPP	3rd Generation Partnership Project
8PSK	Octagonal Phase Shift Keying
AGC	Automatic Gain Control
A-GPS	Assisted GPS
API	Application Programming Interface
BeiDou	BeiDou Navigation Satellite System A Chinese system that uses a series of satellites in geostationary and middle earth orbits to provide navigational data.
BER	Bit Error Rate—A measure of receive sensitivity
BLER	Block Error Rate
bluetooth	Wireless protocol for data exchange over short distances
CQI	Channel Quality Indication
COM	Communication port
CS	Circuit-switched
CSG	Closed Subscriber Group
CW	Continuous waveform
dB	Decibel = 10 x $\log_{10}$ (P1/P2) *P1 is calculated power; P2 is reference power* Decibel = 20 x $\log_{10}$ (V1/V2) *V1 is calculated voltage, V2 is reference voltage*
dBm	A logarithmic (base 10) measure of relative power (dB for decibels); relative to milliwatts (m). A dBm value will be 30 units (1000 times) larger (less negative) than a dBW value, because of the difference in scale (milliwatts vs. watts).
DC-HSPA+	Dual Carrier HSPA+
DCS	Digital Cellular System A cellular communication infrastructure that uses the 1.8 GHz radio spectrum.
DL	Downlink (network to mobile)
DRX	Discontinuous Reception
DSM	Distributed Shared Memory
DUT	Device Under Test
eICIC	Enhanced Inter-Cell Interference Coordination
EIRP	Effective (or Equivalent) Isotropic Radiated Power

Table H-1: Acronyms and Definitions (Continued)

Acronym or term	Definition
EMC	Electromagnetic Compatibility
EMI	Electromagnetic Interference
ERP	Effective Radiated Power
ESD	Electrostatic Discharge
FCC	Federal Communications Commission The U.S. federal agency that is responsible for interstate and foreign communications. The FCC regulates commercial and private radio spectrum management, sets rates for communications services, determines standards for equipment, and controls broadcast licensing. Consult www.fcc.gov.
FDD	Frequency Division Duplexing
FDMA	Frequency Division Multiple Access
feICIC	Further Enhanced Inter-Cell Interference Coordination
FER	Frame Error Rate—A measure of receive sensitivity.
firmware	Software stored in ROM or EEPROM; essential programs that remain even when the system is turned off. Firmware is easier to change than hardware but more permanent than software stored on disk.
FOTA	Firmware Over The Air—Technology used to download firmware upgrades directly from the service provider, over the air.
FOV	Field Of View
FSN	Factory Serial Number—A unique serial number assigned to the mini card during manufacturing.
Galileo	A European system that uses a series of satellites in middle earth orbit to provide navigational data.
GCF	Global Certification Forum
GLONASS	Global Navigation Satellite System—A Russian system that uses a series of 24 satellites in middle circular orbit to provide navigational data.
GMSK	Gaussian Minimum Shift Keying modulation
GNSS	Global Navigation Satellite Systems (GPS, GLONASS, BeiDou, and Galileo)
GPS	Global Positioning System An American system that uses a series of 24 satellites in middle circular orbit to provide navigational data.
Host	The device into which an embedded module is integrated
HSDPA	High Speed Downlink Packet Access
HSPA+	Enhanced HSPA, as defined in 3GPP Release 7 and beyond
HSUPA	High Speed Uplink Packet Access
Hz	Hertz = 1 cycle/second

Table H-1: Acronyms and Definitions (Continued)

Acronym or term	Definition
IC	Industry Canada
IF	Intermediate Frequency
IMEI	International Mobile Equipment Identity
IMS	IP Multimedia Subsystem—Architectural framework for delivering IP multimedia services.
inrush current	Peak current drawn when a device is connected or powered on
inter-RAT	Radio Access Technology
IOT	Interoperability Testing
IS	Interim Standard. After receiving industry consensus, the TIA forwards the standard to ANSI for approval.
ISIM	IMS Subscriber Identity Module (Also referred to as a SIM card)
LED	Light Emitting Diode. A semiconductor diode that emits visible or infrared light.
LHCP	Left-Hand Circular Polarized
LNA	Low Noise Amplifier
LPM	Low Power Mode
LPT	Line Print Terminal
LTE	Long Term Evolution—a high-performance air interface for cellular mobile communication systems.
MCS	Modulation and Coding Scheme
MHz	Megahertz = 10e6 Hz
MIMO	Multiple Input Multiple Output—wireless antenna technology that uses multiple antennas at both transmitter and receiver side. This improves performance.
NAS/AS	Network Access Server
NC	No Connect
NIC	Network Interface Card
NLIC	Non-Linear Interference Cancellation
NMEA	National Marine Electronics Association
OEM	Original Equipment Manufacturer—a company that manufactures a product and sells it to a reseller.
OFDMA	Orthogonal Frequency Division Multiple Access
OMA DM	Open Mobile Alliance Device Management—A device management protocol.
OTA	'Over the air' (or radiated through the antenna)

Table H-1: Acronyms and Definitions (Continued)

Acronym or term	Definition
PA	Power Amplifier
packet	A short, fixed-length block of data, including a header, that is transmitted as a unit in a communications network.
PCB	Printed Circuit Board
PCC	Primary Component Carrier
PCS	Personal Communication System A cellular communication infrastructure that uses the 1.9 GHz radio spectrum.
PDN	Packet Data Network
PMI	Pre-coding Matrix Index
PSS	Primary synchronisation signal
PST	Product Support Tools
PTCRB	PCS Type Certification Review Board
QAM	Quadrature Amplitude Modulation. This form of modulation uses amplitude, frequency, and phase to transfer data on the carrier wave.
QCI	QoS Class Identifier
QMI	Qualcomm MSM/Modem Interface
QOS	Quality of Service
QPSK	Quadrature Phase-Shift Keying
QPST	Qualcomm Product Support Tools
QZSS	Quasi-Zenith Satellite System—Japanese system for satellite-based augmentation of GPS.
RAT	Radio Access Technology
RF	Radio Frequency
RI	Ring Indicator
roaming	A cellular subscriber is in an area where service is obtained from a cellular service provider that is not the subscriber's provider.
RSE	Radiated Spurious Emissions
RSSI	Received Signal Strength Indication
SCC	Secondary Component Carrier
SDK	Software Development Kit
SED	Smart Error Detection
Sensitivity (Audio)	Measure of lowest power signal that the receiver can measure.

Table H-1: Acronyms and Definitions (Continued)

Acronym or term	Definition
Sensitivity (RF)	Measure of lowest power signal at the receiver input that can provide a prescribed BER/BLER/SNR value at the receiver output.
SG	An LTE signaling interface for SMS ("SMS over SGs")
SIB	System Information Block
SIM	Subscriber Identity Module. Also referred to as USIM or UICC.
SIMO	Single Input Multiple Output—smart antenna technology that uses a single antenna at the transmitter side and multiple antennas at the receiver side. This improves performance and security.
SISO	Single Input Single Output—antenna technology that uses a single antenna at both the transmitter side and the receiver side.
SKU	Stock Keeping Unit—identifies an inventory item: a unique code, consisting of numbers or letters and numbers, assigned to a product by a retailer for purposes of identification and inventory control.
SMS	Short Message Service. A feature that allows users of a wireless device on a wireless network to receive or transmit short electronic alphanumeric messages (up to 160 characters, depending on the service provider).
S/N	Signal-to-noise (ratio)
SNR	Signal-to-Noise Ratio
SOF	Start of Frame—A USB function.
SSS	Secondary synchronisation signal.
SUPL	Secure User Plane Location
TDD	Time Division Duplexing
TD-SCDMA	Time Division Synchronous Code Division Multiple Access
TIA/EIA	Telecommunications Industry Association / Electronics Industry Association. A standards setting trade organization, whose members provide communications and information technology products, systems, distribution services and professional services in the United States and around the world. Consult www.tiaonline.org.
TIS	Total Isotropic Sensitivity
TRP	Total Radiated Power
UDK	Universal Development Kit (for PCI Express Mini Cards)
UE	User Equipment
UICC	Universal Integrated Circuit Card (Also referred to as a SIM card.)
UL	Uplink (mobile to network)
UMTS	Universal Mobile Telecommunications System
USB	Universal Serial Bus

Table H-1: Acronyms and Definitions (Continued)

Acronym or term	Definition
USIM	Universal Subscriber Identity Module (UMTS)
VCC	Supply voltage
VSWR	Voltage Standing Wave Ratio
WAN	Wide Area Network
WCDMA	Wideband Code Division Multiple Access (also referred to as UMTS)
WLAN	Wireless Local Area Network
ZIF	Zero Intermediate Frequency
ZUC	ZUC stream cypher

≫ Index

Numerics